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Kawashima

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(54) **METHOD FOR MANUFACTURING A QUARTZ CRYSTAL UNIT, QUARTZ CRYSTAL OSCILLATOR AND ELECTRONIC APPARATUS**

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H03H 3/04	(2006.01)
H03H 9/21	(2006.01)
H03H 9/10	(2006.01)
H03H 9/05	(2006.01)
H04R 31/00	(2006.01)
H03H 9/215	(2006.01)
H04R 17/00	(2006.01)
H03B 5/32	(2006.01)

(52) **U.S. Cl.**

CPC **H03H 9/1021** (2013.01); **H04R 17/00** (2013.01); **H03H 9/0547** (2013.01); **H03B 5/32** (2013.01); **H03H 3/02** (2013.01); **H04R 31/00** (2013.01); **Y10T 29/49004** (2015.01); **Y10T 29/42** (2015.01); **Y10T 29/49574** (2015.01); **Y10T 29/49005** (2015.01); **Y10T 29/4913** (2015.01); **H03H 9/215** (2013.01); **H03H 2003/026** (2013.01); **H03H 2003/0492** (2013.01)

(58) **Field of Classification Search**

CPC H03H 3/02; H03H 9/0547; H03H 9/215; H03H 9/1021; H03H 2003/026; H03H 2003/0492; H04R 17/00; H04R 31/00; Y10T 29/49004; Y10T 29/49005; Y10T 29/49574; Y10T 29/42; Y10T 29/4913; H03B 5/32
USPC 29/25.35, 594, 896.22, 842, 846, 25.41, 29/610.1; 310/370, 348, 361; 331/158
See application file for complete search history.

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(57)

ABSTRACT

In a method for manufacturing a quartz crystal unit, a metal film is formed on a quartz crystal wafer which is then etched to form a quartz crystal tuning fork resonator having first and second tines vibratable in flexural and fundamental modes. A groove is chemically etched in a first main surface of both tines such that a first surface of the groove is opposite a first side surface of the corresponding tine. The width of the groove is greater than a distance in the width direction from the groove first surface to the first side surface of the corresponding tine. An electrode is formed on each groove first surface and on the first side surface of both tines with the electrode on the groove first surface of the first tine having the same electrical polarity as the electrode on the first side surface of the second tine.

33 Claims, 13 Drawing Sheets

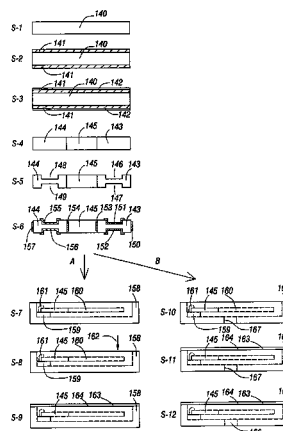
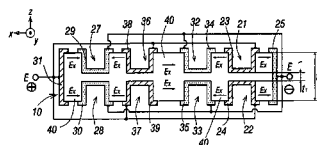


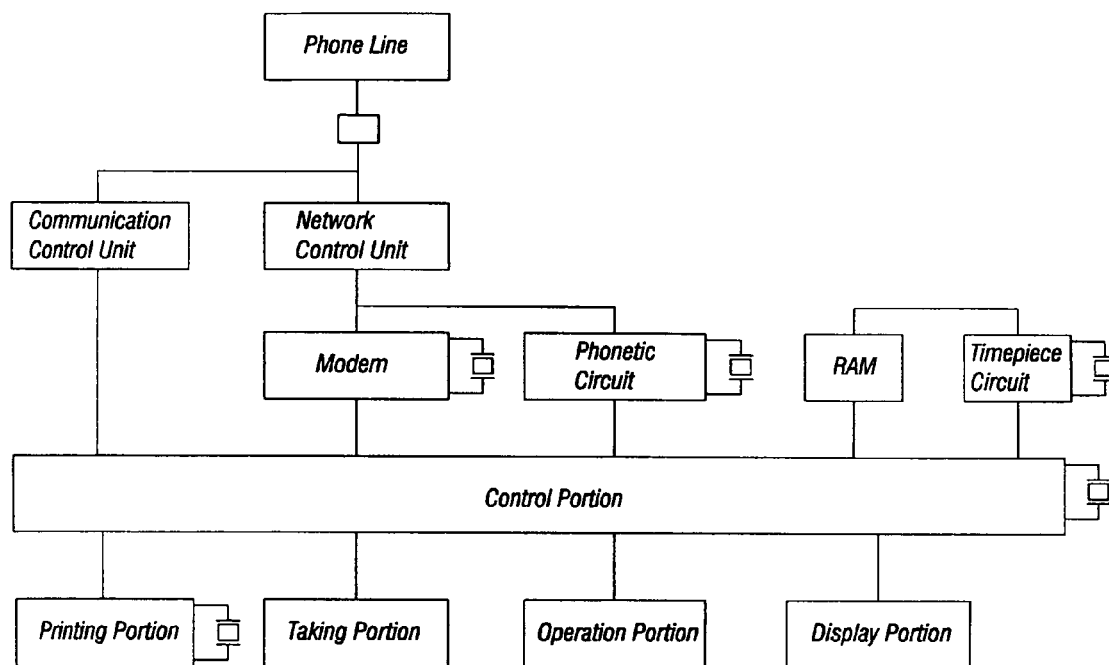
FIG. 1

FIG. 2

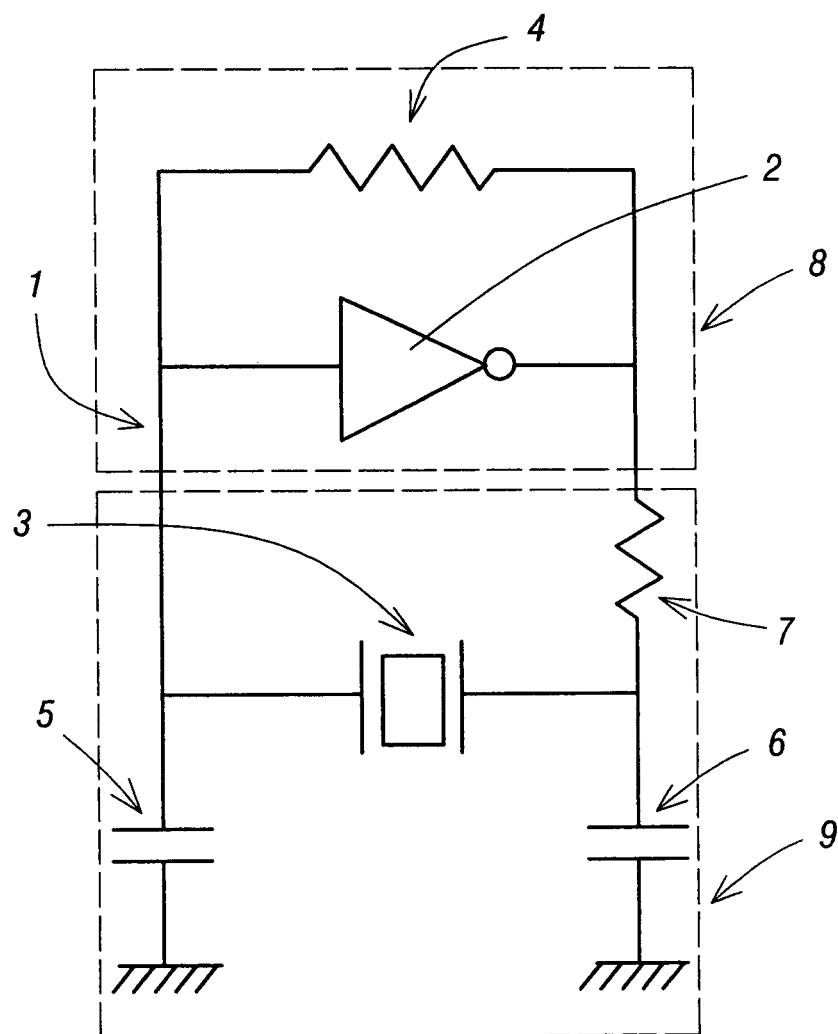


FIG. 3

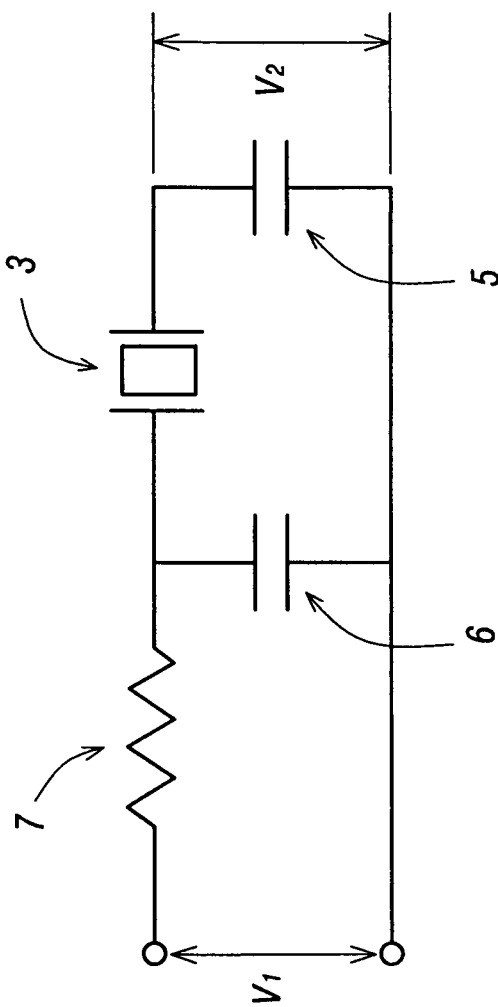


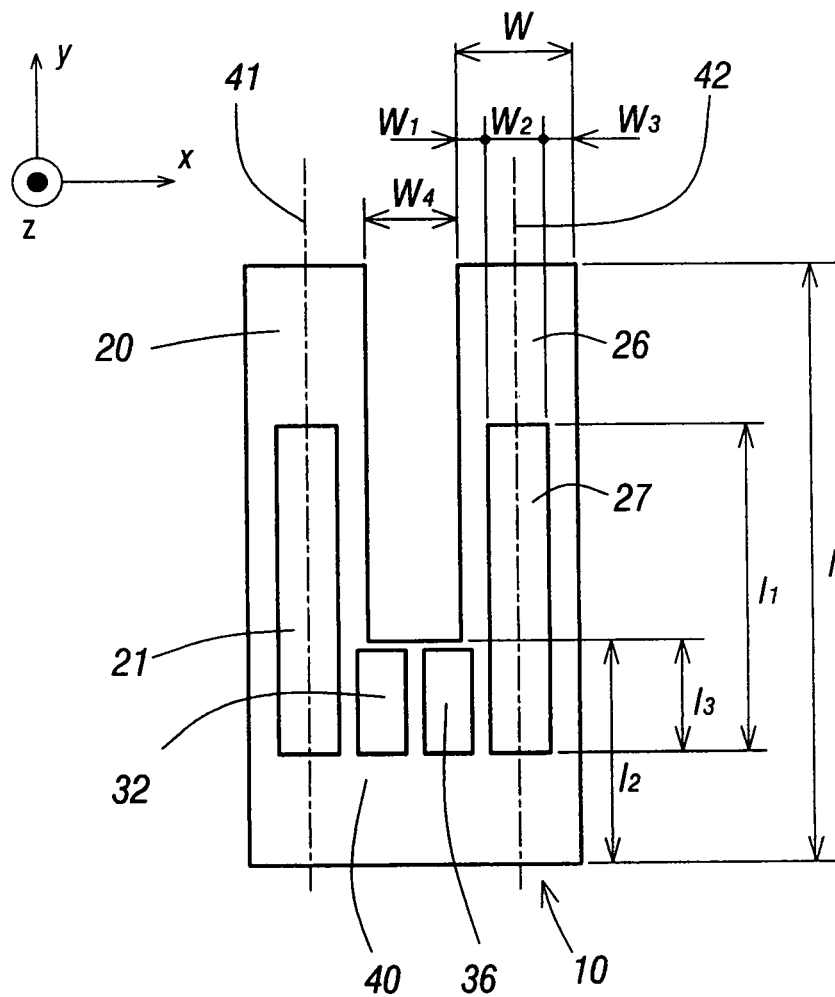
FIG. 6

FIG. 7

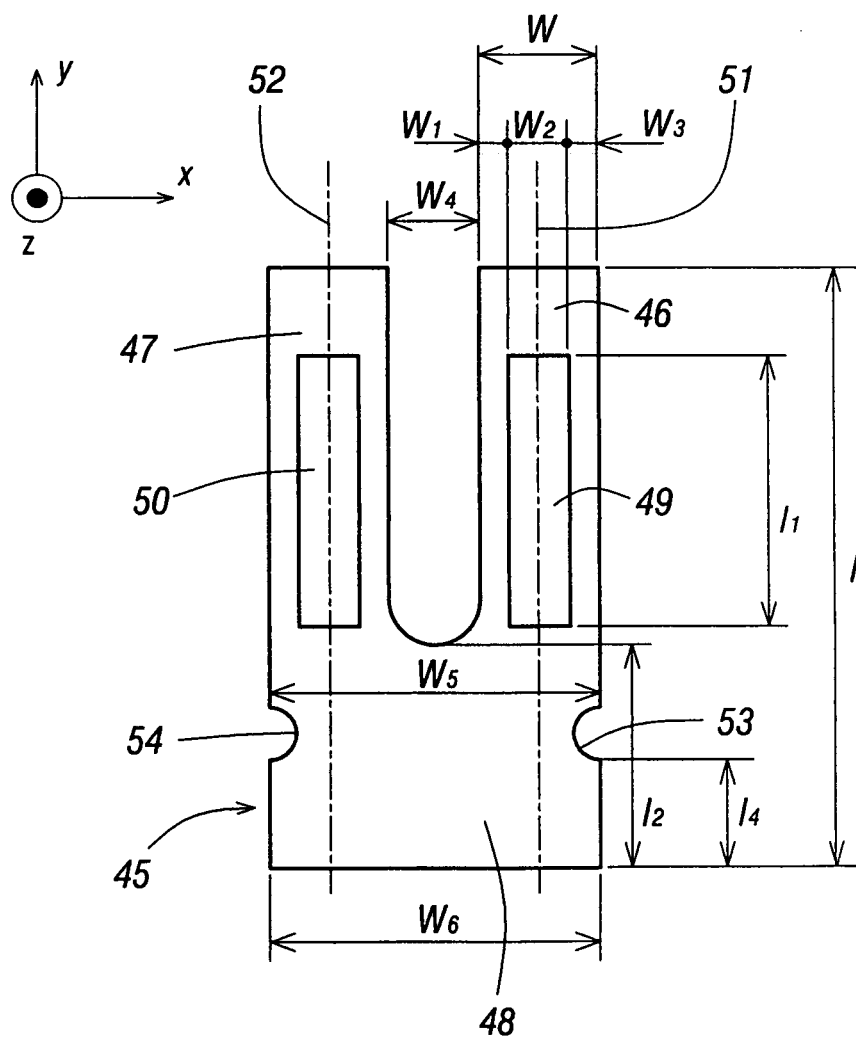


FIG. 8a

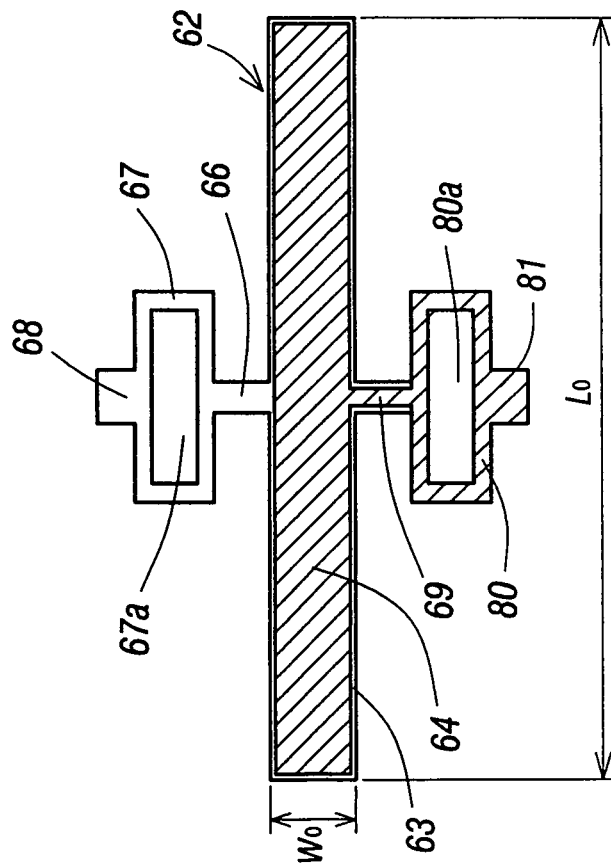


FIG. 8b

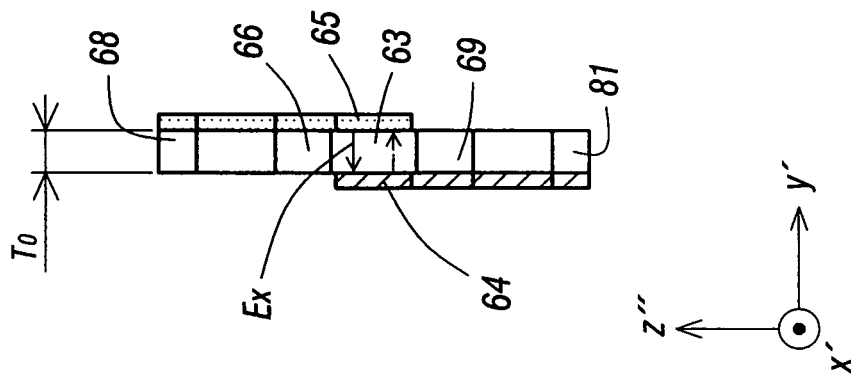


FIG. 9

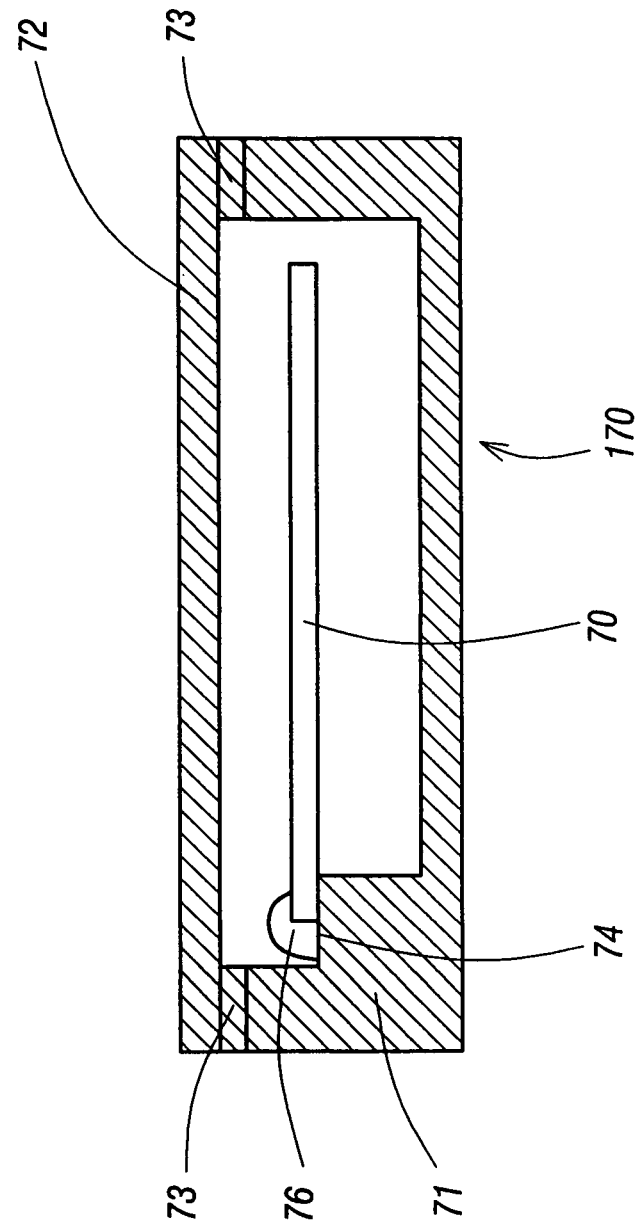


FIG. 10

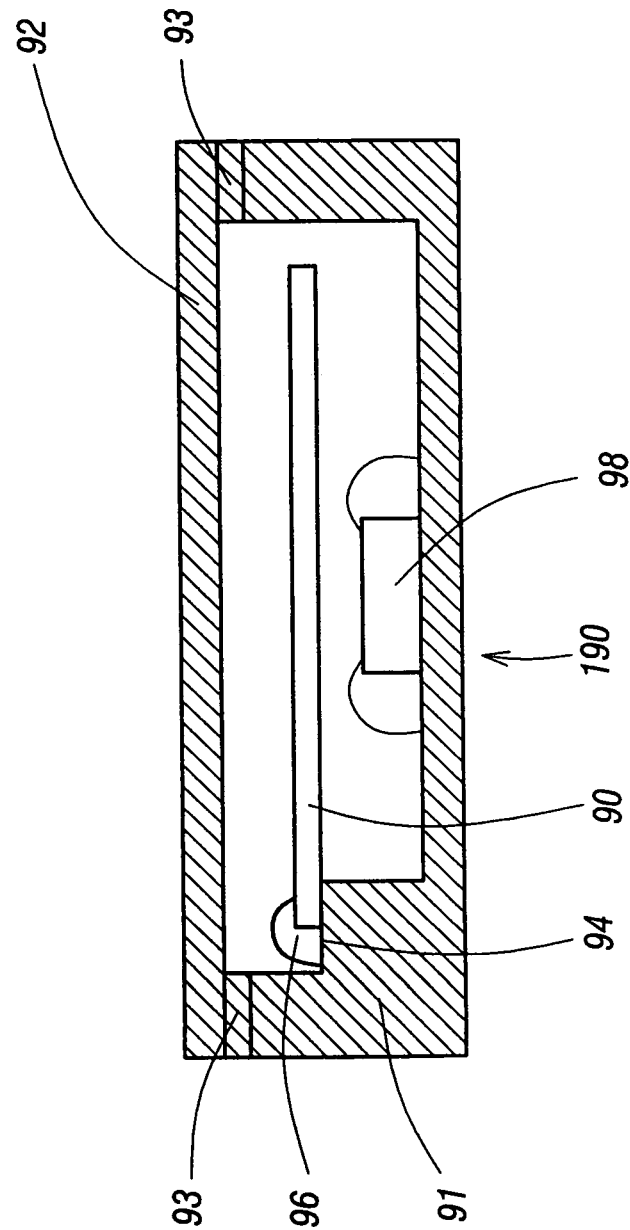


FIG. 11

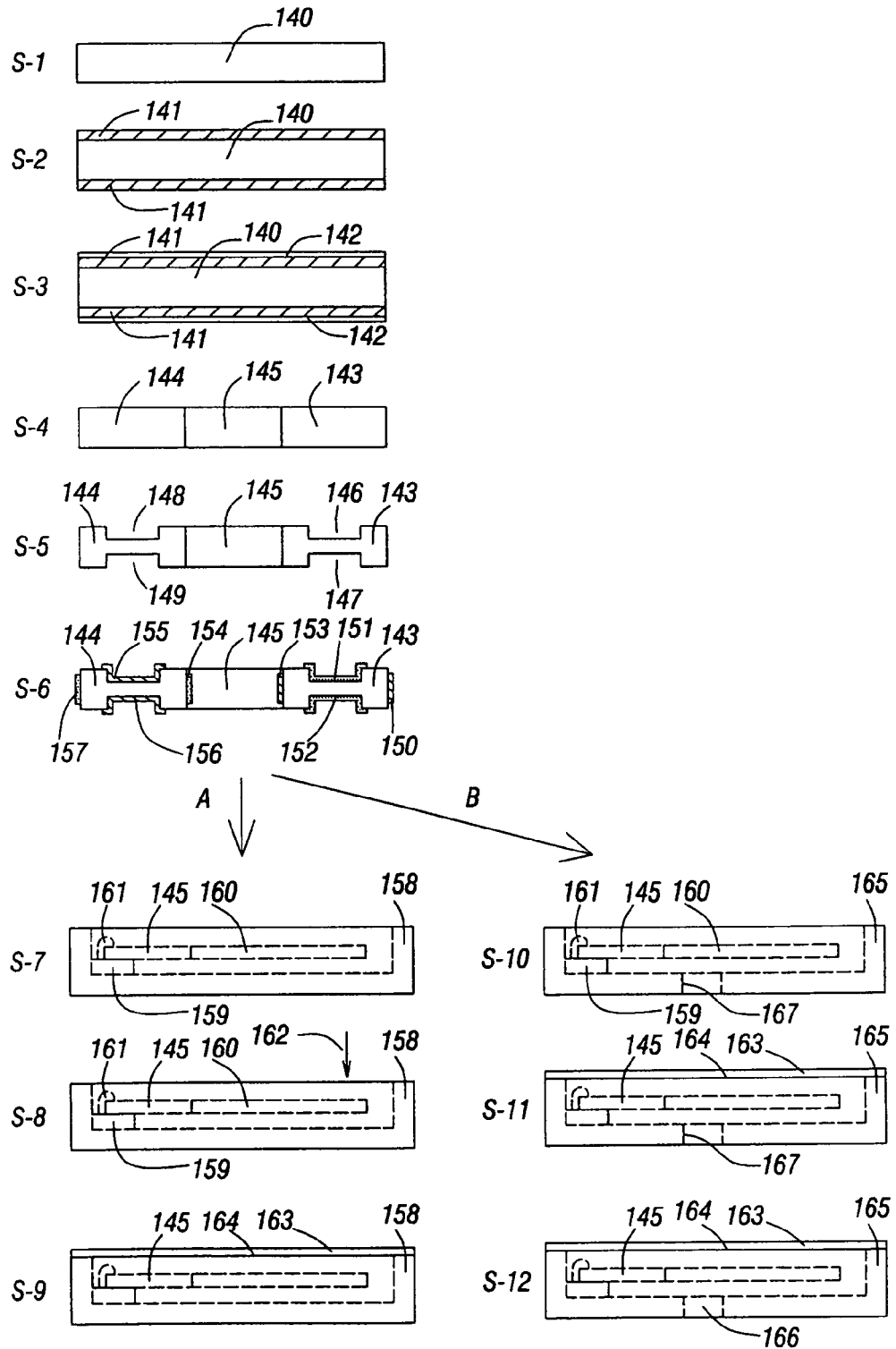


FIG. 12

PRIOR ART

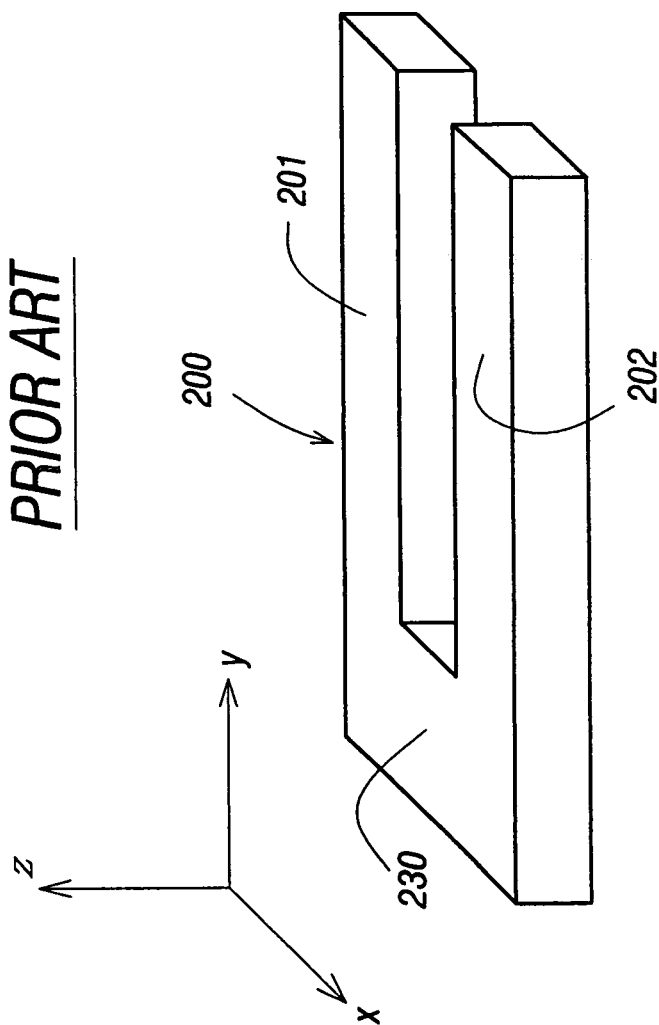
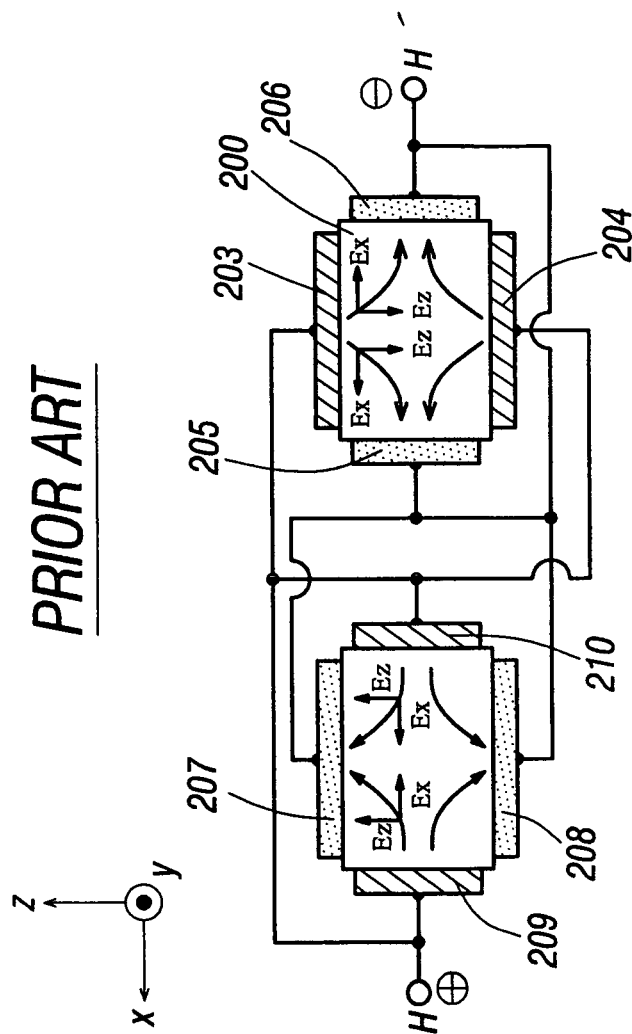


FIG. 13
PRIOR ART



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METHOD FOR MANUFACTURING A QUARTZ CRYSTAL UNIT, QUARTZ CRYSTAL OSCILLATOR AND ELECTRONIC APPARATUS

CROSS REFERENCE TO RELATED APPLICATIONS

This application is a continuation of application Ser. No. 12/459,030 filed Jun. 25, 2009, and now U.S. Pat. No. 8,091, 189, which is a continuation of application Ser. No. 11/821, 753 filed Jun. 25, 2007, and now U.S. Pat. No. 7,564,326, which is a continuation of application Ser. No. 11/398,876 filed Apr. 6, 2006 and now abandoned, which is a division of application Ser. No. 10/749,182 filed Dec. 30, 2003 and now U.S. Pat. No. 7,071,794, which is a continuation-in-part of U.S. patent application Ser. No. 10/378,719 filed Mar. 4, 2003 and now abandoned.

FIELD OF THE INVENTION

The present invention relates to an electronic apparatus comprising a display portion and a quartz crystal oscillator at least.

BACKGROUND OF THE INVENTION

There are many electronic apparatus comprising a display portion and a quartz crystal oscillator at least. For example, cellular phones, wristwatches, facsimiles and pagers comprising a quartz crystal oscillator are well known. Recently, because of high stability for frequency, miniaturization and the light weight nature of these electronic apparatus, the need for an electronic apparatus comprising a smaller quartz crystal oscillator with a high frequency stability has arisen. For example, the quartz crystal oscillator with a quartz crystal tuning fork resonator, which is capable of vibrating in a flexural mode, is widely used as a time standard in an electronic apparatus such as the cellular phones, the wristwatches, the facsimiles and the pagers. Similar to this, the same need has also arisen for an electronic apparatus comprising a length-extensional mode quartz crystal resonator with a frequency of 1 MHz to 10 MHz to decrease an electric current consumption of the electronic apparatus.

Heretofore, however, it has been impossible to obtain an electronic apparatus comprising a smaller quartz crystal oscillator with a conventional miniaturized quartz crystal tuning fork resonator, capable of vibrating in a flexural mode, and having a high frequency stability, a small series resistance and a high quality factor. When miniaturized, the conventional quartz crystal tuning fork resonator, capable of vibrating in a flexural mode, as shown in FIG. 12 (which has electrodes on the obverse faces **203**, **207**, reverse faces **204**, **208** and the four sides **205**, **206**, **209**, **210** of each tuning fork tine, as also shown in FIG. 13—a cross-sectional view of tuning fork tines of FIG. 12), it has a smaller electromechanical transformation efficiency because the resonator shape and the electrode construction provide a small electric field (i.e. Ex becomes small), as a result of which the resonator has a low frequency stability, a large series resistance and a reduced quality factor. In FIG. 12, a conventional tuning fork resonator **200** is shown with tines **201**, **202** and a base **230**.

Moreover, for example, Japanese Patent Nos. P56-65517 and P2000-223992A and International Patent No. WO 00/44092 were published and teach grooves and electrodes constructed at tuning fork tines of a flexural mode, tuning fork, quartz crystal resonator. However, they teach nothing

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about a quartz crystal oscillator of the present invention having novel shape, novel electrode construction and figure of merit M for a quartz crystal tuning fork resonator, capable of vibrating in a flexural mode and about a relationship of an amplification circuit and a feedback circuit which construct a quartz crystal oscillating circuit.

Additionally, for example, there has been a big problem in the conventional oscillator with the conventional quartz crystal tuning fork resonator, such that a fundamental mode vibration of the resonator jumps to a second overtone mode vibration by shock or vibration.

Similarly, however, it has been impossible to obtain an electronic apparatus comprising a smaller quartz crystal oscillator with a conventional length-extensional mode quartz crystal resonator, capable of vibrating in a length-extensional mode, and having a frequency of 1 MHz to 10 MHz, a small series resistance and a high quality factor. As an example of a length-extensional mode quartz crystal resonator of the prior art, the length-extensional mode resonator comprising a vibrational portion, connecting portions and supporting portions, which is formed from a Z plate perpendicular to z axis, is well known, and this resonator is formed integrally by a chemical etching process. Also, electrodes are disposed opposite each other on sides of the vibrational portion formed by the chemical etching process so that the electrodes disposed opposite each other are of opposite electrical polarity.

Also, a cutting angle of the conventional length-extensional mode quartz crystal resonator is generally within a range of ZYw (0° to +5°), according to an IEEE notation. In detail, the connecting portions are connected opposite each other at both end portions of a width of the vibrational portion and at a central portion of the length direction thereof. Namely, the direction of the connecting portions constructed opposite each other corresponds to the direction of the electric field.

When an alternating current (AC) voltage is applied between the electrodes, an electric field occurs alternately in the width direction, as a result, the resonator is capable of vibrating in the length direction, but the electric field of between the electrodes becomes very small because quartz crystal is an anisotropic material and the sides of the vibrational portion have a complicated shape formed by the chemical etching process. Namely, the resonator has small electromechanical transformation efficiency because the resonator's shape and the electrode construction provide a small electric field, consequently, the resonator has a low frequency stability, a large series resistance and a reduced quality factor when it has the frequency of 1 MHz to 10 MHz.

It is, therefore, a general object of the present invention to provide embodiments of an electronic apparatus and a quartz crystal oscillator, which constructs an electronic apparatus of the present invention, comprising a quartz crystal oscillating circuit with a flexural mode, quartz crystal tuning fork resonator, capable of vibrating in a fundamental mode, and having a high frequency stability, a small series resistance and a high quality factor, or embodiments of a quartz crystal oscillator, which also constructs an electronic apparatus of the present invention, comprising a quartz crystal oscillating circuit with a length-extensional mode quartz crystal resonator having a frequency of 1 MHz to 10 MHz, a small series resistance and a high quality factor, which overcome or at least mitigate one or more of the above problems.

SUMMARY OF THE INVENTION

The present invention relates to an electronic apparatus comprising a display portion and a quartz crystal oscillator at

least, and the quartz crystal oscillator comprises a quartz crystal oscillating circuit having an amplification circuit and a feedback circuit, and in particular, relates to a quartz crystal oscillator having a flexural mode, quartz crystal tuning fork resonator capable of vibrating in a fundamental mode and having an output signal of a high frequency stability for the fundamental mode vibration of the resonator, and also to a quartz crystal oscillator having a suppressed second overtone mode vibration of the flexural mode, quartz crystal tuning fork resonator, in addition, relates to a quartz crystal oscillator comprising a length-extensional mode quartz crystal resonator. The quartz crystal oscillators are, therefore, available for the electronic apparatus requiring miniaturized and low priced quartz crystal oscillators with high time accuracy and shock proof.

It is an object of the present invention to provide an electronic apparatus comprising a quartz crystal oscillator with a miniature quartz crystal tuning fork resonator, capable of vibrating in a flexural mode, and having a high frequency stability, a small series resistance R_1 and a high quality factor Q_1 , whose nominal frequency for a fundamental mode vibration is within a range of 10 kHz to 200 kHz.

It is another object of the present invention to provide an electronic apparatus comprising a quartz crystal oscillator with a flexural mode, quartz crystal tuning fork resonator, capable of vibrating in a fundamental mode, and having a high frequency stability which gives a high time accuracy.

It is a further object of the present invention to provide an electronic apparatus comprising a quartz crystal oscillator with a length-extensional mode quartz crystal resonator.

According to one aspect of the present invention, there is provided an electronic apparatus comprising a display portion and a quartz crystal oscillator at least, and said electronic apparatus having one quartz crystal oscillator, said one quartz crystal oscillator comprising: a quartz crystal oscillating circuit comprising: an amplification circuit comprising an amplifier at least and a feedback circuit comprising a quartz crystal resonator and capacitors at least, said quartz crystal resonator being a quartz crystal tuning fork resonator, capable of vibrating in a flexural mode, and said quartz crystal tuning fork resonator comprising: tuning fork tines each of which has a length, a width and a thickness and the length greater than the width and the thickness; and a tuning fork base; said tuning fork tines and said tuning fork base that are formed integrally; and electrodes disposed facing each other on sides of said tuning fork tines so that the electrodes disposed facing each other are of opposite electrical polarity and said tuning fork tines are capable of vibrating in inverse phase,

According to a second aspect of the present invention there is provided an electronic apparatus comprising a display portion and a quartz crystal oscillator at least, and said electronic apparatus comprises at least one quartz crystal oscillator comprising: an oscillating circuit comprising: an amplification circuit comprising an amplifier at least, and a feedback circuit comprising a length-extensional mode quartz crystal resonator which is one of a contour mode quartz crystal resonator.

According to a third aspect of the present invention, there is provided a method for manufacturing an electronic apparatus comprising a display portion and a quartz crystal oscillator at least, and said electronic apparatus comprising at least one quartz crystal oscillator, said at least one oscillator comprising: a quartz crystal oscillating circuit comprising: an amplification circuit comprising an amplifier at least, and a feedback circuit comprising a quartz crystal resonator and capacitors at least, said quartz crystal resonator being a quartz crystal tuning fork resonator, capable of vibrating in a flexural

mode, said quartz crystal tuning fork resonator comprising the steps of: forming integrally tuning fork tines each of which has a length, a width and a thickness and the length greater than the width and the thickness and a tuning fork base; disposing electrodes facing each other on sides of said tuning fork tines so that the electrodes disposed facing each other are of opposite electrical polarity and said tuning fork tines vibrate in an inverse phase; and adjusting resonance frequency of said quartz crystal tuning fork resonator after mounting it at a mounting portion by conductive adhesives or solder so that a frequency deviation is within a range of -100 PPM to +100 PPM.

According to a fourth aspect of the present invention, there are provided a quartz crystal resonator, a quartz crystal unit and a quartz crystal oscillator, each of which has a piezoelectric constant e_{12} that is within a range of 0.095 C/m² to 0.19 C/m².

Preferably, said tuning fork resonator is constructed so that figure of merit M_1 of a fundamental mode vibration is larger than figure of merit M_2 of a second overtone mode vibration.

Preferably, the quartz crystal oscillator with said tuning fork resonator is constructed so that a ratio of an amplification rate α_1 of the fundamental mode vibration and an amplification rate α_2 of the second overtone mode vibration of said amplification circuit is larger than that of a feedback rate β_2 of the second overtone mode vibration and a feedback rate β_1 of the fundamental mode vibration of said feedback circuit, and a product of the amplification rate α_1 and the feedback rate β_1 of the fundamental mode vibration is larger than 1.

Preferably, the quartz crystal oscillator with said tuning fork resonator is constructed so that a ratio of an absolute value of negative resistance, $|-RL_1|$ of the fundamental mode vibration of said amplification circuit and series resistance R_1 of the fundamental mode vibration is larger than that of an absolute value of negative resistance, $|-RL_2|$ of the second overtone mode vibration of said amplification circuit and series resistance R_2 of the second overtone mode vibration.

Preferably, the length-extensional mode quartz crystal resonator comprises a vibrational portion, connecting portions and supporting portions, which are formed integrally by a particle method.

The present invention will be more fully understood by referring to the following detailed specification and claims taken in connection with the appended drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 shows a block diagram of an embodiment of an electronic apparatus of the present invention, and illustrating the diagram of a facsimile apparatus;

FIG. 2 shows a diagram of an embodiment of a quartz crystal oscillating circuit constructing a quartz crystal oscillator, which constructs an electronic apparatus of the present invention;

FIG. 3 shows a diagram of the feedback circuit of FIG. 2;

FIG. 4 shows a general view of a flexural mode, quartz crystal tuning fork resonator constructing a quartz crystal oscillator, which constructs an electronic apparatus of the first embodiment of the present invention;

FIG. 5 shows a D-D' cross-sectional view of the tuning fork base of FIG. 4, and illustrating electrode construction;

FIG. 6 shows a plan view of a quartz crystal tuning fork resonator of FIG. 4;

FIG. 7 shows a plan view of a flexural mode, quartz crystal tuning fork resonator constructing a quartz crystal oscillator, which constructs an electronic apparatus of the second embodiment of the present invention;

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FIG. 8a and FIG. 8b show a top view and a side view of a length-extensional mode quartz crystal resonator constructing a quartz crystal oscillator, which constructs an electronic apparatus of the third embodiment of the present invention;

FIG. 9 shows a cross-sectional view of a quartz crystal unit constructing a quartz crystal oscillator, which constructs an electronic apparatus of the fourth embodiment of the present invention;

FIG. 10 shows a cross-sectional view of a quartz crystal oscillator, which constructs an electronic apparatus of the fifth embodiment of the present invention;

FIG. 11 shows a step diagram of a method for manufacturing a quartz crystal unit constructing a quartz crystal oscillator, which constructs an electronic apparatus of the present invention;

FIG. 12 is a general view of the conventional flexural mode, quartz crystal tuning fork resonator constructing a quartz crystal oscillator of the prior art, which constructs the conventional electronic apparatus; and

FIG. 13 is a cross-sectional view of the tuning fork tines of FIG. 12, and illustrating electrode construction.

DETAILED DESCRIPTION

Referring now to the drawings, the embodiments of the present invention will be described in more detail.

FIG. 1 shows a block diagram of an embodiment of an electronic apparatus of the present invention, and illustrating the diagram of a facsimile apparatus. As is shown in FIG. 1, the apparatus generally comprises a modem, a phonetic circuit, a timepiece circuit, a printing portion, a taking portion, an operation portion and a display portion. In this principle, perception and scanning of reflection light of light projected on manuscript in the taking portion are performed by CCD (Charge Coupled Device), in addition, light and shade of the reflection light are transformed into a digital signal, and the signal is modulated by the modem and is sent to a phone line (Communication line). Also, in a receiving side, a received signal is demodulated by the modem and is printed on a paper in the print portion by synchronizing the received signal with a signal of a sending side.

As shown in FIG. 1, a quartz crystal resonator is used as a CPU clock of the control portion and the printing portion, as a clock of the phonetic circuit and the modem, and as a time standard of the timepiece. Namely, the resonator constructs a quartz crystal oscillator and an output signal of the oscillator is used. For example, it is used as a signal to display time at the display portion. In this case, a quartz crystal tuning fork resonator, capable of vibrating in a flexural mode is used, and e.g. as the CPU clock, a contour mode quartz crystal resonator such as a length-extensional mode quartz crystal resonator or a thickness shear mode quartz crystal resonator is used. In order to get the facsimile apparatus of this embodiment which operates normally, an accuracy output signal of the oscillator is required for the facsimile apparatus, which is one of the electronic apparatus of the present invention. Also, a digital display and an analogue display are included in the display of the present invention.

In this embodiment, though the facsimile apparatus is shown as an example of an electronic apparatus, the present invention is not limited to this, namely, the present invention includes all electronic apparatus, each of which comprises a quartz crystal oscillator and a display portion at least, for example, cellular phones, telephones, a TV set, cameras, a video set, video cameras, pagers, personal computers, print-

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ers, CD players, MD players, electronic musical instruments, car navigators, car electronics, timepieces, IC cards and so forth.

FIG. 2 shows a diagram of an embodiment of a quartz crystal oscillating circuit constructing a quartz crystal oscillator, which constructs an electronic apparatus of the present invention. The quartz crystal oscillating circuit 1 comprises an amplifier (CMOS Inverter) 2, a feedback resistor 4, a drain resistor 7, capacitors 5, 6 and a flexural mode, quartz crystal tuning fork resonator 3. Namely, the oscillating circuit 1 comprises an amplification circuit 8 having the amplifier 2 and the feedback resistor 4, and a feedback circuit 9 having the drain resistor 7, the capacitors 5, 6 and the quartz crystal tuning fork resonator 3. In addition, an output signal of the oscillating circuit 1 comprising the quartz crystal tuning fork resonator 3, capable of vibrating in a fundamental mode, is outputted through buffer circuit (not shown in FIG. 2).

In detail, an oscillation frequency of the fundamental mode vibration is outputted through a buffer circuit as an output signal. According to the present invention, a nominal frequency of the fundamental mode vibration of the resonator is within a range of 10 kHz to 200 kHz. Especially, 32.768 kHz is an important frequency. In general, the output signal has an oscillation frequency which is within a range of -100 PPM to +100 PPM to the nominal frequency, e.g. 32.768 kHz. In more detail, the quartz crystal oscillator in this embodiment comprises a quartz crystal oscillating circuit and a buffer circuit, namely, the quartz crystal oscillating circuit comprises an amplification circuit and a feedback circuit, and the amplification circuit comprises an amplifier and a feedback resistor, and the feedback circuit comprises a flexural mode, quartz crystal tuning fork resonator, a drain resistor and capacitors. Also, flexural mode, quartz crystal tuning fork resonators which are used in a quartz crystal oscillator will be described in FIG. 4-FIG. 7 in detail. Instead of the flexural mode, quartz crystal tuning fork resonator, a contour mode resonator such as a length-extensional mode quartz crystal resonator, a width-extensional mode quartz crystal resonator and a Lamé mode quartz crystal resonator or a thickness shear mode quartz crystal resonator may be used.

FIG. 3 shows a diagram of the feedback circuit of FIG. 2. Now, when angular frequency ω_i of the flexural mode, quartz crystal tuning fork resonator 3, capable of vibrating in a flexural mode, a resistance R_d of the drain resistor 7, capacitance C_g , C_d of the capacitors 5, 6, crystal impedance R_{ei} of the quartz crystal resonator 3, an input voltage V_1 , and an output voltage V_2 are taken, a feedback rate β_i is defined by $\beta_i = V_2/V_1$, where i shows vibration order, for example, when $i=1$ and 2, they are for a fundamental mode vibration and a second overtone mode vibration.

In addition, load capacitance C_L is given by $C_L = C_g C_d / (C_g + C_d)$, and when $C_g = C_d = C_{gd}$ and $R_d \gg R_{ei}$, the feedback rate β_i is given by $\beta_i = 1 / (1 + k C_L^2)$, where k is expressed by a function of ω_i , R_d and R_{ei} . Also, R_{ei} is approximately equal to series resistance R_s .

Thus, it is easily understood from a relationship of the feedback rate β_i and load capacitance C_L that the feedback rate of resonance frequency for a fundamental mode vibration and an overtone mode vibration becomes large, respectively, according to decrease of load capacitance C_L . Therefore, when C_L has a small value, an oscillation of the overtone mode occurs very easily, instead of that of the fundamental mode. This is the reason why a maximum amplitude of the overtone mode vibration becomes smaller than that of the fundamental mode vibration, and the oscillation of the overtone mode satisfies an amplitude condition and a phase con-

dition simultaneously which are the continuous condition of an oscillation in an oscillating circuit.

As it is also one object of the present invention to provide a quartz crystal oscillator having a flexural mode, quartz crystal tuning fork resonator, capable of vibrating in a fundamental mode and having a high frequency stability (high time accuracy) of an output signal, and having reduced electric current consumption, in this embodiment, load capacitance C_L is less than 25 pF to reduce electric current consumption. To get much reduced electric current consumption, C_L is preferably less than 15 pF because electric current consumption is proportional to C_L .

In addition, in order to suppress a second overtone mode vibration and to obtain a quartz crystal oscillator having an output signal of an oscillation frequency of a fundamental mode vibration, the quartz crystal oscillator in this embodiment is constructed so that it satisfies a relationship of $\alpha_1/\alpha_2 > \beta_2/\beta_1$ and $\alpha_1\beta_1 > 1$, where α_1 and α_2 are, respectively, an amplification rate of the fundamental mode vibration and the second overtone mode vibration of an amplification circuit, and β_1 and β_2 are, respectively, a feedback rate of the fundamental mode vibration and the second overtone mode vibration of a feedback circuit.

In other words, the quartz crystal oscillator is constructed so that a ratio of the amplification rate α_1 of the fundamental mode vibration and the amplification rate α_2 of the second overtone mode vibration of the amplification circuit is larger than that of the feedback rate β_2 of the second overtone mode vibration and the feedback rate β_1 of the fundamental mode vibration of the feedback circuit, and also a product of the amplification rate α_1 and the feedback rate β_1 of the fundamental mode vibration is larger than 1. A description of the high frequency stability will be performed later.

Also, characteristics of the amplifier of the amplification circuit constructing the quartz crystal oscillating circuit of this embodiment can be expressed by negative resistance $-RL_i$. For example, when $i=1$, negative resistance $-RL_1$ is for a fundamental mode vibration and when $i=2$, negative resistance $-RL_2$ is for a second overtone mode vibration. In this embodiment, the quartz crystal oscillating circuit is constructed so that a ratio of an absolute value of negative resistance, $|-RL_1|$ of the fundamental mode vibration of the amplification circuit and series resistance R_1 of the fundamental mode vibration is larger than that of an absolute value of negative resistance, $|-RL_2|$ of the second overtone mode vibration of the amplification circuit and series resistance R_2 of the second overtone mode vibration. That is to say, the oscillating circuit is constructed so that it satisfies a relationship of $|-RL_1|/R_1 > |-RL_2|/R_2$. By constructing the oscillating circuit like this, an oscillation of the second overtone mode can be suppressed, as a result of which an output signal of a frequency of the fundamental mode vibration can be provided because an oscillation of the fundamental mode generates easily in the oscillating circuit.

FIG. 4 shows a general view of a flexural mode, quartz crystal tuning fork resonator **10** which is one of a contour mode resonator, constructing a quartz crystal oscillator, which constructs an electronic apparatus of the first embodiment of the present invention and its coordinate system o-xyz. A cut angle θ which has a typical value of 0° to 10° is rotated from a Z-plate perpendicular to the z axis about the x axis. The resonator **10** comprises two tuning fork tines (vibrating tines) **20** and **26** and a tuning fork base (a base) **40**. The tines **20** and **26** have grooves **21** and **27** respectively, with the grooves **21** and **27** extending into the base **40**. Also, the base **40** has the

additional grooves **32** and **36**. In addition, the tines **20** and **26** vibrate in a flexural mode of a fundamental mode and an inverse phase.

FIG. 5 shows a D-D' cross-sectional view of the tuning fork base **40** of the quartz crystal resonator **10** in FIG. 4. In FIG. 5, the shape of the electrode construction within the base **40** for the quartz crystal resonator of FIG. 4 is described in detail. The section of the base **40** which couples to the tine **20** has the grooves **21** and **22** cut into the obverse and reverse faces of the base **40**. Also, the section of the base **40** which couples to the tine **26** has the grooves **27** and **28** cut into the obverse and reverse faces of the base **40**. In addition to these grooves, the base **40** has the grooves **32** and **36** cut between the grooves **21** and **27**, and also, the base **40** has the grooves **33** and **37** cut between the grooves **22** and **28**.

Furthermore, the grooves **21** and **22** have the first electrodes **23** and **24** both of the same electrical polarity, the grooves **32** and **33** have the second electrodes **34** and **35** both of the same electrical polarity, the grooves **36** and **37** have the third electrodes **38** and **39** both of the same electrical polarity, the grooves **27** and **28** have the fourth electrodes **29** and **30** both of same electrical polarity and the sides of the base **40** have the fifth and sixth electrodes **25** and **31**, each of opposite electrical polarity. In more detail, the fifth, fourth, and second electrodes **25**, **29**, **30**, **34** and **35** have the same electrical polarity, while the first, sixth and third electrodes **23**, **24**, **31**, **38** and **39** have the opposite electrical polarity to the others. Two electrode terminals E-E' are constructed. That is, the electrodes disposed inside the grooves constructed opposite each other in the thickness (z axis) direction have the same electrical polarity. Also, the electrodes disposed opposite each other across adjoining grooves have opposite electrical polarity.

In addition, the resonator has a thickness t of the tines or the tines and the base, and a groove thickness t_1 . It is needless to say that the electrodes are disposed inside the grooves and on the sides of the tines. In this embodiment, the first electrodes **23** and **24** are disposed at the tine and the base, and also, the fourth electrodes **29** and **30** are disposed at the tine and the base. In addition, the electrodes are disposed on the sides of the tines opposite each other to the electrodes disposed inside the grooves. Namely, the electrodes are disposed opposite each other inside the grooves and on the sides of the tines so that the electrodes disposed opposite each other are of opposite electrical polarity. Additionally, electrodes are disposed facing each other on the sides of the tines so that the electrodes disposed facing each other are of opposite electrical polarity, and the tines are capable of vibrating in inverse phase. In more detail, a first tuning fork tine and a second tuning fork tine, and a tuning fork base are formed integrally, an electrode is disposed on both sides of the first tine and the second tine so that the electrodes disposed (facing each other) on inner sides of the first and second tines are of opposite electrical polarity.

When a direct voltage is applied between the electrode terminals E-E' (E terminal: plus, E' terminal: minus), an electric field E_x occurs in the arrow direction as shown in FIG. 5. As the electric field E_x occurs perpendicular to the electrodes disposed on the base, the electric field E_x has a very large value and a large distortion occurs at the base, so that the quartz crystal tuning fork resonator is obtained with a small series resistance R_1 and a high quality factor Q_1 , even if it is miniaturized.

FIG. 6 shows a plan view of the resonator **10** of FIG. 4. In FIG. 6, the construction and the dimension of grooves **21**, **27**, **32** and **36** are described in detail. The groove **21** is constructed to include a portion of the central line **41** of the tine **20**, and the groove **27** is similarly constructed to include a portion of the

central line 42 of the tine 26. The width W_2 of the grooves 21 and 27 (groove width W_2) which include a portion of the central lines 41 and 42 respectively, is preferable because moment of inertia of the tines 20 and 26 becomes large and the tines can vibrate in a flexural mode easily. As a result, the quartz crystal tuning fork resonator capable of vibrating in a fundamental mode can be obtained with a small series resistance R_1 and a high quality factor Q_1 .

In more detail, when part widths W_1 , W_3 and a groove width W_2 are taken, the tine width W of the tines 20 and 26 has a relationship of $W=W_1+W_2+W_3$, and the part widths W_1 , W_3 are constructed so that $W_1 \geq W_3$ or $W_1 < W_3$. In addition, the groove width W_2 is constructed so that $W_2 \geq W_1$, W_3 . In this embodiment, also, the grooves are constructed at the tines so that a ratio (W_2/W) of the groove width W_2 and the tine width W is larger than 0.35 and less than 1, and a ratio (t_1/t) of the groove thickness t_1 and the thickness t of the tines (tine thickness t) is less than 0.79, to obtain very large moment of inertia of the tines. That is, the flexural mode, quartz crystal tuning fork resonator, capable of vibrating in the fundamental mode, and having a good frequency stability can be provided with a small series resistance R_1 , a high quality factor Q_1 and a small capacitance ratio r_1 because electromechanical transformation efficiency of the resonator becomes large markedly.

Likewise, a length l_1 of the grooves 21, 27 provided at the tines 20, 26 extends into the base 40 in this embodiment (which has a dimension of the length l_2 and the length l_3 of the grooves). Therefore, a groove length and a length of the tines are given by (l_1-l_3) and ($l-l_2$), respectively, and a ratio of (l_1-l_3) and ($l-l_2$) is within a range of 0.4 to 0.8 to get a flexural mode tuning fork resonator with series resistance R_1 of a fundamental mode vibration smaller than series resistance R_2 of a second overtone mode vibration. Also, a length l_2 of the base is less than 0.5 mm.

Furthermore, the total length l is determined by the frequency requirement and the size of the housing case. Simultaneously, to get a flexural mode, quartz crystal tuning fork resonator, capable of vibrating in a fundamental mode with suppression of the second overtone mode vibration which is an unwanted mode vibration, there is a close relationship between the groove length l_1 and the total length l . Namely, a ratio (l_1/l) of the groove length l_1 and the total length l is within a range of 0.2 to 0.78 because the quantity of charges which generate within the grooves and on the sides of the tines or the tines and the base can be controlled by the ratio, as a result, the second overtone mode vibration which is an unwanted mode vibration, can be suppressed, and simultaneously, a frequency stability of the fundamental mode vibration gets high. Therefore, the flexural mode, quartz crystal tuning fork resonator, capable of vibrating easily in a fundamental mode and having high frequency stability can be provided. Also, the total length l is less than 2.18 mm, preferably, within a range of 1.2 mm to 2 mm, and groove length l_1 is less than 1.29 mm, preferably, within a range of 0.35 mm to 1.15 mm, to get a smaller-sized tuning fork resonator which vibrates in a flexural mode and a fundamental mode.

In more detail, series resistance R_1 of the fundamental mode vibration becomes smaller than series resistance R_2 of the second overtone mode vibration. Namely, $R_1 < R_2$, preferably, $R_1 < 0.86R_2$, therefore, a quartz crystal oscillator comprising an amplifier (CMOS inverter), capacitors, resistors and a quartz crystal unit with the quartz crystal tuning fork resonator of this embodiment can be obtained, which is capable of vibrating in the fundamental mode easily. In addition, in this embodiment the grooves 21 and 27 of the tines 20 and 26 extend into the base 40 in series, but embodiment of the present invention includes a plurality of grooves divided

into the length direction of the tines. In addition, the grooves may be constructed only at the tines ($l_3=0$).

In this embodiment, the groove length l_1 corresponds to electrode length disposed inside the grooves, though the electrode is not shown in FIG. 6, but, when the electrode length is less than the groove length, the length l_1 is of the electrode length. Namely, the ratio (l_1/l) in this case is expressed by a ratio of electrode length l_1 of the grooves and the total length l . In order to achieve the above-mentioned object, it may be satisfied with at least one groove with the ratio constructed at the obverse and reverse faces of each tine. As a result, the flexural mode, quartz crystal tuning fork resonator, capable of vibrating very easily in the fundamental mode and having the high frequency stability can be realized. Also, a fork portion of this embodiment has a rectangular shape, but this invention is not limited to this, for example, the fork portion may have a U shape.

In addition, a spaced-apart distance between the tines is given by W_4 , and in this embodiment, the distance W_4 and the groove width W_2 are constructed so that $W_4 \geq W_2$, and more, the distance W_4 is within a range of 0.05 mm to 0.35 mm and the groove width W_2 is within a range of 0.03 mm to 0.12 mm because it is easy to form a tuning fork shape and grooves of the tuning fork tines separately by a photo-lithographic process and an etching process, consequently, a frequency stability for a fundamental mode vibration gets higher than that for a second overtone mode vibration. In this embodiment, a quartz wafer with the thickness t of 0.05 mm to 0.15 mm is used. In order to get a smaller-sized quartz crystal tuning fork resonator, capable of vibrating in a flexural mode, it is necessary that groove width W_2 is less than 0.07 mm and tine width W is less than 0.18 mm, and preferably, the W is larger than 0.05 mm and less than 0.1 mm. Also, a groove thickness t_1 is within a range of 0.01 mm to 0.085 mm approximately, and part widths W_1 , W_3 are less than 0.021 mm, respectively, preferably, less than 0.015 mm. In addition, a groove provided on at least one of an obverse face and a reverse face of each of tuning fork tines of the present invention may be a through hole, namely, a groove thickness $t_1=0$.

In more detail, to obtain a flexural mode, quartz crystal tuning fork resonator with a high frequency stability which gives high time accuracy, it is necessary to obtain the resonator whose resonance frequency is not influenced by shunt capacitance because quartz crystal is a piezoelectric material and the frequency stability is very dependent on the shunt capacitance. In order to decrease the influence on the resonance frequency by the shunt capacitance, figure of merit M_i plays an important role. Namely, the figure of merit M_i that expresses inductive characteristics, electromechanical transformation efficiency and a quality factor of a flexural mode, quartz crystal tuning fork resonator, is defined by a ratio (Q_i/r_i) of a quality factor Q_i and capacitance ratio r_i , namely, M_i is given by $M_i=Q_i/r_i$, where i shows vibration order of the resonator, and for example, when $i=1$ and 2, figures of merit M_1 and M_2 are a value for a fundamental mode vibration and a second overtone mode vibration of the flexural mode, quartz crystal tuning fork resonator, respectively.

Also, a frequency difference Δf of resonance frequency f_s of mechanical series independent on the shunt capacitance and resonance frequency f_r dependent on the shunt capacitance is inversely proportional to the figure of merit M_i . The larger the value M_i becomes, the smaller the difference Δf becomes. Namely, the influence on the resonance frequency f_r by the shunt capacitance decreases because it is close to the resonance frequency f_s . Accordingly, the larger the M_i becomes, the higher the frequency stability of the flexural mode, quartz crystal tuning fork resonator becomes because

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the resonance frequency f_r of the resonator is almost never dependent on the shunt capacitance. Namely, the quartz crystal tuning fork resonator can be provided with a high time accuracy.

In detail, the flexural mode, quartz crystal tuning fork resonator can be obtained with figure of merit M_1 of the fundamental mode vibration larger than figure of merit M_2 of the second overtone mode vibration by the above-described tuning fork shape, grooves and dimensions. That is to say, a relationship of $M_1 > M_2$ is obtained. As an example, when resonance frequency of a flexural mode, quartz crystal tuning fork resonator is about 32.768 kHz for a fundamental mode vibration and the resonator has a value of $W_2/W = 0.5$, $t_1/t = 0.34$ and $l_1/l = 0.48$, though there is a distribution in production, the resonator has a value of $M_1 > 65$ and $M_2 < 30$, respectively.

Namely, the flexural mode, quartz crystal tuning fork resonator which vibrates in the fundamental mode can be provided with high inductive characteristics, good electromechanical transformation efficiency (small capacitance ratio r_1 and small series resistance R_1) and a high quality factor. As a result, a frequency stability of the fundamental mode vibration becomes higher than that of the second overtone mode vibration, and simultaneously, the second overtone mode vibration can be suppressed because capacitance ratio r_2 and series resistance R_2 of the second overtone mode vibration become larger than capacitance ratio r_1 and series resistance R_1 of the fundamental mode vibration, respectively. In particular, r_2 has a value larger than 1500 in this embodiment.

Therefore, the resonator capable of vibrating in the fundamental mode vibration can be provided with a high time accuracy because it has the high frequency stability. Consequently, a quartz crystal oscillator comprising the flexural mode, quartz crystal tuning fork resonator of this embodiment outputs an oscillation frequency of the fundamental mode vibration as an output signal; and the frequency of the output signal has a very high stability, namely, excellent time accuracy. In other words, the quartz crystal oscillator of this embodiment has a remarkable effect such that a frequency change by ageing becomes extremely small. Also, an oscillation frequency of the resonator of this embodiment is adjusted so that a frequency deviation is within a range of -100 PPM to $+100$ PPM to a nominal frequency, e.g. 32.768 kHz, after mounting it at a mounting portion of a case or a lid by conductive adhesives or solder.

In addition, the groove thickness t_1 of the present invention is the thinnest thickness of the grooves because quartz crystal is an anisotropic material and the groove thickness t_1 has a distribution when it is formed by a chemical etching method. In detail, a groove shape of the sectional view of tuning fork tines in FIG. 5 has a rectangular shape, but the groove shape has an about U shape actually. In the above-described embodiments, though the grooves are constructed at the tines, this invention is not limited to this, namely, a relationship of the figures of merit M_1 and M_2 can be applied to the conventional flexural mode, quartz crystal tuning fork resonator and a relationship of a quartz crystal oscillating circuit comprising an amplification circuit and a feedback circuit can be also applied to the conventional flexural mode, quartz crystal tuning fork resonator to suppress a second overtone mode vibration and to get a high frequency stability for a fundamental mode vibration of the tuning fork resonator.

FIG. 7 shows a plan view of a flexural mode, quartz crystal tuning fork resonator 45 which is one of a contour mode quartz crystal resonator, constructing a quartz crystal oscillator, which constructs an electronic apparatus of the second embodiment of the present invention. The resonator 45 com-

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prises tuning fork tines 46, 47 and a tuning fork base 48. The tines 46, 47 and the base 48 are formed integrally by a chemical etching process. In this embodiment, the base 48 has cut portions 53 and 54. Also, a groove 49 is constructed to include a portion of the central line 51 of the tine 46, and a groove 50 is similarly constructed to include a portion of the central line 52 of the tine 47. In this embodiment, the grooves 49 and 50 are constructed at a part of the tines 46 and 47, and have groove width W_2 and groove length l_1 . In more detail, a groove area $S (= W_2 \times l_1)$ has a value of 0.025 mm^2 to 0.12 mm^2 because it is very easy to form the grooves by a chemical etching process and the quartz crystal tuning fork resonator can be provided with good electromechanical transformation efficiency by the formation of the grooves.

Namely, the quartz crystal tuning fork resonator, capable of vibrating in a fundamental mode and having a high frequency stability can be provided with a small series resistance R_1 and a high quality factor Q_1 . Therefore, a quartz crystal oscillator having the high frequency stability can be realized with an output signal of a frequency of the fundamental mode vibration. In this embodiment, though electrodes are not shown in FIG. 7, the electrodes are disposed inside the grooves 49, 50 and on sides of the tines 46 and 47, similar to the resonator of FIG. 4. In detail, the electrodes are disposed opposite each other inside the grooves and on the sides of the tines so that the electrodes disposed opposite each other are of opposite electrical polarity. In more detail, a groove is provided on both of an obverse face and a reverse face of tuning fork tines having a first tuning fork tine and a second tuning fork tine, and also, a first electrode is disposed inside the groove and a second electrode is disposed on both sides of the tuning fork tines. In addition, a quartz crystal tuning fork resonator has two electrode terminals, the one of the electrode terminals comprises a first electrode disposed inside a groove provided on both of the obverse face and the reverse face of the first tuning fork tine and a second electrode disposed on the both sides of the second tuning fork tine, such that the first and second electrodes are connected, and the other of the electrode terminals comprises a second electrode disposed on the both sides of the first tuning fork tine and a first electrode disposed inside a groove provided on both of the obverse face and the reverse face of the second tuning fork tine, such that the second and first electrodes are connected. In this embodiment, a groove is provided on both of an obverse face and a reverse face of tuning fork tines, but the present invention is not limited to this, for example, a groove may be provided on at least one of an obverse face and a reverse face of tuning fork tines.

In addition, the base 48 has cut portions 53 and 54, and the cut base 48 has a dimension of width W_5 (tines side) and width W_6 (opposite side to the tines side). When the base 48 is mounted at a mounting portion (e.g. on two lead wires for a package of a tubular type) of a case or a lid of a surface mounting type or a tubular type by solder or conductive adhesives, it is necessary to satisfy $W_6 \geq W_5$ to decrease energy losses by vibration. The cut portions 53 and 54 are very effective to decrease the energy losses. Therefore, the flexural mode, quartz crystal tuning fork resonator, capable of vibrating in the fundamental mode and having the high frequency stability (high time accuracy) can be provided with a small series resistance R_1 and a high quality factor Q_1 . Also, the width dimensions $W = W_1 + W_2 + W_3$ and W_4 , and the length dimensions l_1 , l_2 and l are as already described in relation to FIG. 6. In addition, a shape of the tuning fork base according to the present invention is not limited to that of this embodiment, for example, a tuning fork base may have a frame

portion protruding from the tuning fork base, and the frame portion is mounted at a mounting portion of a case or a lid of a package.

FIG. 8a and FIG. 8b are a top view and a side view for a length-extensional mode quartz crystal resonator which is one of a contour mode resonator, constructing a quartz crystal oscillator, which constructs an electronic apparatus of the third embodiment of the present invention. The resonator 62 comprises a vibrational portion 63, connecting portions 66, 69 and supporting portions 67, 80 including respective mounting portions 68, 81. In addition, the supporting portions 67 and 80 have respective holes 67a and 80a. Also, electrodes 64 and 65 are disposed opposite each other on upper and lower faces of the vibrational portion 63, and the electrodes have opposite electrical polarities. Namely, a pair of electrodes is disposed on the vibrational portion. In this case, a fundamental mode vibration can be excited easily.

In addition, the electrode 64 extends to the mounting portion 81 through the one connecting portion 69 and the electrode 65 extends to the mounting portion 68 through the other connecting portion 66. In this embodiment, the electrodes 64 and 65 disposed on the vibrational portion 63 extend to the mounting portions of the different direction each other. But, the electrodes may be constructed in the same direction. The resonator in this embodiment is mounted on fixing portions of a case or a lid at the mounting portions 68 and 81 by conductive adhesives or solder.

Here, a cutting angle of the length-extensional mode quartz crystal resonator is shown. First, a quartz crystal plate perpendicular to x axis, so called, X plate quartz crystal is taken. Length L_0 , width W_0 and thickness T_0 which are each dimension of the X plate quartz crystal correspond to the respective directions of y, z and x axes.

Next, this X plate quartz crystal is, first, rotated with an angle θ_x of -30° to $+30^\circ$ about the x axis, and second, rotated with an angle θ_y of -40° to $+40^\circ$ about y' axis which is the new axis of the y axis. In this case, the new axis of the x axis changes to x' axis and the new axis of the z axis changes to z' axis because the z axis is rotated twice about two axes. The length-extensional mode quartz crystal resonator of the present invention is formed from the quartz crystal plate with the rotation angles.

In other words, according to an expression of IEEE notation, a cutting angle of the resonator of the present invention can be expressed by XYtl(-30° to $+30^\circ$)/(-40° to $+40^\circ$). By choosing a cutting angle of the resonator, a turn over temperature point T_p can be taken at an arbitrary temperature. In this embodiment, length L_0 , width W_0 and thickness T_0 correspond to y', z' and x' axes, respectively. But, when the X plate is rotated once about the x axis, the z' axis corresponds to the z' axis. In addition, the vibrational portion 63 has a dimension of length L_0 greater than width W_0 and thickness T_0 smaller than the width W_0 . Namely, a coupling between length-extensional mode and width-extensional mode gets so small as it can be ignored, as a result of which, the quartz crystal resonator can vibrate in a single length-extensional mode.

In more detail, resonance frequency of the length-extensional mode resonator is inversely proportional to length L_0 , and it is almost independent on such an other dimension as width W_0 , thickness T_0 , connecting portions and supporting portions. Also, in order to obtain a length-extensional mode quartz crystal resonator capable of vibrating in a fundamental mode with a frequency of 1 MHz to 10 MHz, the length L_0 is within a range of about 0.26 mm to about 2.7 mm. In addition, when a length-extensional mode resonator vibrates in an overtone mode, an odd number (n) pair of electrodes are disposed on a vibrational portion of the resonator, where n has

a value of 1, 3, 5, In this case, the length L_0 is a range of about (0.26 to 2.7)×n mm. Thus, the miniature length-extensional mode resonator can be provided with the frequency of 1 MHz to 10 MHz.

Next, a value of a piezoelectric constant e_{12} ($=e'_{12}$) is described, which is of great importance and necessary to excite a flexural mode, quartz crystal resonator and a length-extensional mode quartz crystal resonator of the present invention. The larger a value of the piezoelectric constant e_{12} becomes, the higher electromechanical transformation efficiency becomes. The piezoelectric constant e_{12} of the present invention can be calculated using the piezoelectric constants $e_{11}=0.171$ C/m² and $e_{14}=-0.0406$ C/m² of quartz crystal. As a result, the piezoelectric constant e_{12} of the present invention is within a range of 0.095 C/m² to 0.19 C/m² approximately in an absolute value. It is, therefore, easily understood that this value is enough large to obtain a flexural mode, quartz crystal tuning fork resonator and a length-extensional mode quartz crystal resonator with a small series resistance R_1 and a high quality factor Q. Especially, in order to obtain a flexural mode, quartz crystal tuning fork resonator with a smaller series resistance R_1 , the e_{12} is within a range of 0.12 C/m² to 0.19 C/m² in the absolute value, and also, a groove and electrodes are provided on at least one of an obverse face and a reverse face of tuning fork tines so that when each tuning fork tine is divided into two portions (an inner portion located at a fork side and an outer portion located opposite to the fork side) versus a central line portion thereof, a value of e_{12} of each portion of each tuning fork tine has an opposite sign each other. Namely, when the one of the two portions has e_{12} of a plus sign, the other of the two portions has e_{12} of a minus sign. In more detail, a groove and electrodes are provided at tuning fork tines so that a sign of e_{12} of inner portions of each tuning fork tine is opposite to the sign of e_{12} of outer portions of each tuning fork tine.

When an alternating current voltage is applied between the electrodes 64 and 65 shown in FIG. 8b, an electric field E_x occurs alternately in the thickness direction, as shown by the arrow direction of the solid and broken lines in FIG. 8b. Consequently, the vibrational portion 63 is capable of extending and contracting in the length direction.

FIG. 9 shows a cross-sectional view of a quartz crystal unit constructing a quartz crystal oscillator, which constructs an electronic apparatus of the fourth embodiment of the present invention. The quartz crystal unit 170 comprises a contour mode quartz crystal resonator 70 or a thickness shear mode quartz crystal resonator 70, a case 71 and a lid 72. In more detail, the resonator 70 is mounted at a mounting portion 74 of the case 71 by conductive adhesives 76 or solder. Also, the case 71 and the lid 72 are connected through a connecting member 73. For example, the contour mode resonator 70 in this embodiment is the same resonator as one of the flexural mode, quartz crystal tuning fork resonators 10 and 45 described in detail in FIG. 4-FIG. 7. Also, in this embodiment, circuit elements are connected at outside of the quartz crystal unit to get a quartz crystal oscillator. Namely, only the quartz crystal tuning fork resonator is housed in the unit and also, it is housed in the unit in vacuum. In this embodiment, the quartz crystal unit of a surface mounting type is shown, but the quartz crystal tuning fork resonator may be housed in a tubular type, namely a quartz crystal unit of the tubular type. Also, instead of the flexural mode, quartz crystal tuning fork resonator and the thickness shear mode quartz crystal resonator, one of a length-extensional mode quartz crystal resonator, a width-extensional mode quartz crystal resonator and a Lamé mode quartz crystal resonator which are a contour mode resonator, respectively, or a SAW (Surface Acoustic

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Wave) resonator may be housed in the unit. In addition, the present invention is not limited to the quartz crystal unit having the contour mode quartz crystal resonator or the thickness shear mode quartz crystal resonator in this embodiment, for example, the present invention also includes a quartz crystal unit having a piezoelectric filter, e.g. a SAW piezoelectric filter or a piezoelectric sensor, e.g. an angular velocity piezoelectric sensor.

In addition, a member of the case and the lid is ceramics or glass and a metal or glass, respectively, and a connecting member is a metal or glass with low melting point. Also, a relationship of the resonator, the case and the lid described in this embodiment is applied to a quartz crystal oscillator of the present invention which will be described in FIG. 10.

FIG. 10 shows a cross-sectional view of a quartz crystal oscillator, which constructs an electronic apparatus of the fifth embodiment of the present invention. The quartz crystal oscillator 190 comprises a quartz crystal oscillating circuit, a case 91 and a lid 92. In this embodiment, circuit elements constructing the oscillating circuit are housed in a quartz crystal unit comprising a contour mode quartz crystal resonator 90 or a thickness shear mode quartz crystal resonator 90, the case 91 and the lid 92. Also, the oscillating circuit of this embodiment comprises an amplifier 98 including a feedback resistor, the resonator 90, capacitors (not shown here) and a drain resistor (not shown here), and a CMOS inverter is used as the amplifier 98.

In addition, in this embodiment, the resonator 90 is mounted at a mounting portion 94 of the case 91 by conductive adhesives 96 or solder. As described above, the amplifier 98 is housed in the quartz crystal unit and mounted at the case 91. Also, the case 91 and the lid 92 are connected through a connecting member 93. For example, the contour mode resonator 90 of this embodiment is the same as one of the flexural mode, quartz crystal tuning fork resonators 10 and 45 described in detail in FIG. 4-FIG. 7. Also, instead of the flexural mode, quartz crystal tuning fork resonator and the thickness shear mode quartz crystal resonator, one of a length-extensional mode quartz crystal resonator, a width-extensional mode quartz crystal resonator and a Lamé mode quartz crystal resonator which are a contour mode resonator, respectively, or a SAW (Surface Acoustic Wave) resonator may be housed in the unit.

Likewise, in this embodiment, a piece of flexural mode, quartz crystal tuning fork resonator is housed in the unit, but the present invention also includes a quartz crystal unit having a plurality of flexural mode, quartz crystal tuning fork resonators, and at least two of the plurality of resonators are connected electrically in parallel. In addition, the at least two resonators may be an individual resonator or may be individual resonators that are formed integrally at each tuning base through a connecting portion.

Next, a method for manufacturing a quartz crystal oscillator, which constructs an electronic apparatus of the present invention, is described in detail, according to the manufacturing steps.

FIG. 11 shows an embodiment of a method for manufacturing a quartz crystal oscillator, which constructs an electronic apparatus of the present invention and a step diagram embodying the present invention. The signs of S-1 to S-12 are the step numbers. First, S-1 shows a cross-sectional view of a quartz crystal wafer 140. Next, in S-2 metal film 141, for example, chromium and gold on the chromium are, respectively, disposed on upper and lower faces of the quartz crystal wafer 140 by an evaporation method or a sputtering method. In addition, resist 142 is spread on said metal film 141 in S-3, and after the metal film 141 and the resist 142 were removed

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except those of tuning fork shape by a photo-lithographic process and an etching process, the tuning fork shape with tuning fork tines 143, 144 and a tuning fork base 145, as be shown in S-4, is integrally formed by a chemical etching process. When the tuning fork shape is formed, cut portions may be formed at the tuning fork base. In FIG. 11, the formation of a piece of tuning fork shape is shown, but, a number of tuning fork shapes are actually formed in a piece of quartz crystal wafer.

Similar to the steps of S-2 and S-3, metal film and resist are spread again on the tuning fork shape of S-4 and grooves 146, 147, 148 and 149 each of which has two step difference portions along the length direction of the tuning fork tines, are formed at the tuning fork tines 143, 144 by the photo-lithographic process and the etching process, and the shape of S-5 is obtained after all of the resist and the metal film were removed. In addition, metal film and resist are spread again on the shape of S-5 and electrodes which are of opposite electrical polarity, are disposed on sides of the tines and inside the grooves thereof, as be shown in S-6.

Namely, electrodes 150, 153 disposed on the sides of the tuning fork tine 143 and electrodes 155, 156 disposed inside the grooves 148, 149 of the tuning fork tine 144 have the same electrical polarity. Similarly, electrodes 151, 152 disposed inside the grooves 146, 147 of the tuning fork tine 143 and electrodes 154, 157 disposed on the sides of the tuning fork tine 144 have the same electrical polarity. Two electrode terminals are, therefore, constructed. In more detail, when an alternating current (AC) voltage is applied between the terminals, the tuning fork tines vibrate in a flexural mode of an inverse phase because said electrodes disposed on step difference portions of the grooves and the electrodes disposed opposite to the said electrodes have opposite electrical polarity. In the step of S-6, a piece of quartz crystal tuning fork resonator, capable of vibrating in a flexural mode is shown in the quartz crystal wafer, but a number of quartz crystal tuning fork resonators are actually formed in the wafer.

In addition, a resonance (oscillation) frequency for said resonators is adjusted by a separate step of at least twice and the first adjustment of resonance frequency for said resonators is performed in the quartz crystal wafer by a laser method or an evaporation method or an ion etching method so that a frequency deviation of said resonators is within a range of -9000 PPM to +5000 PPM (Parts Per Million) to a nominal frequency of 10 kHz to 200 kHz, e.g. 32,768 kHz. The adjustment of frequency by the laser or ion etching method is performed by trimming mass disposed on tuning fork tines and the adjustment of frequency by the evaporation method is performed by adding mass on tuning fork tines. Namely, those methods can change the resonance (oscillation) frequency of said resonators. Also, the resonators formed in the quartz crystal wafer are inspected therein and when there is a failure resonator, it is removed from the wafer or something is marked on it or it is remembered by a computer.

In this embodiment, the tuning fork shape is formed from the step of S-3 and after that, the grooves are formed at the tuning fork tines, namely, the tuning fork tines are formed before the grooves are formed, but this invention is not limited to said embodiment, for example, the grooves are first formed from the step of S-3 and after that, the tuning fork shape may be formed, namely, the grooves are formed before the tuning fork tines are formed. Also, the tuning fork shape and the grooves may be formed simultaneously, namely, the tuning fork tines and the grooves are formed simultaneously.

There are two methods of A and B in the following step, as be shown by arrow signs. For the step of A, the tuning fork base 145 of the formed flexural mode, quartz crystal tuning

fork resonator **160** is first mounted on mounting portion **159** of a case **158** by conductive adhesives **161** or solder, as be shown in S-7. Next, the second adjustment of resonance (oscillation) frequency for the resonator **160** is performed by laser **162** or evaporation or ion etching method in S-8 so that a frequency deviation is within a range of -100 PPM to $+100$ PPM to the nominal frequency of 10 kHz to 200 kHz, e.g. 32.768 kHz. Finally, the case **158** and a lid **163** are connected via glass **164** with the low melting point or a metal in S-9. In this case, the connection of the case and the lid is performed in vacuum because the case **158** has no hole to close it in vacuum.

In addition, though it is not visible in FIG. **11**, the third frequency adjustment may be performed by laser after the step of the connection of S-9 to get a small frequency deviation to the nominal frequency when a material of the lid is glass. As a result of which it is possible to get the resonator with the frequency deviation which is within a range of -50 PPM to $+50$ PPM to the nominal frequency of 10 kHz to 200 kHz, e.g. 32.768 kHz. Namely, the nominal frequency, capable of vibrating in a fundamental mode is less than 200 kHz. In this step, when the third frequency adjustment is performed, a/an resonance (oscillation) frequency of said resonators is adjusted so that the frequency deviation by the second frequency adjustment is within a range of -950 PPM to $+950$ PPM to the nominal frequency, e.g. 32.768 kHz.

For the step of B, the tuning fork base **145** of the formed resonator **160** is first mounted on a mounting portion **159** of a case **165** by conductive adhesives **161** or solder in S-10, in addition, in S-11 the case **165** and a lid **163** are connected by the same way as that of S-9, in more detail, after the resonator was mounted on the mounting portion of the case or after the resonator was mounted at the mounting portion, and the case and the lid were connected, the second adjustment of resonance (oscillation) frequency is performed so that a frequency deviation is generally within a range of -100 PPM to $+100$ PPM to a nominal frequency of 10 kHz to 200 kHz, e.g. 32.768 kHz in vacuum, but, it may be within a wider range, for example, -950 PPM to $+950$ PPM when the third frequency adjustment as will be shown as follows, is performed. Finally, a hole **167** constructed at the case **165** is closed in vacuum using such a metal **166** as solder or glass with the low melting point in S-12.

Also, similar to the step of A, the third adjustment of resonance (oscillation) frequency may be performed by laser after the step of S-12 to get a small frequency deviation to the nominal frequency. As a result of which it is possible to get the resonator with the frequency deviation which is within a range of -50 PPM to $+50$ PPM to the nominal frequency, e.g. 32.768 kHz. Thus, a frequency deviation of the resonators in the case of A and B is finally within a range of -100 PPM to $+100$ PPM at most. Also, the second frequency adjustment may be performed after the case and the lid were connected and the hole was closed in vacuum. In addition, the hole is constructed at the case, but may be constructed at the lid. Also, the frequency adjustment of the present invention is performed in vacuum or inert gas such as nitrogen gas or atmosphere, and the values described above are values in vacuum.

Therefore, the flexural mode, quartz crystal tuning fork resonators and the quartz crystal units manufactured by the above-described method are miniaturized and realized with a small series resistance R_1 , a high quality factor Q_1 and low price.

Moreover, in the above-described embodiment, though the first frequency adjustment of the resonators is performed in the quartz crystal wafer and at the same time, when there is a

failure resonator, something is marked on it or it is removed from the quartz crystal wafer, but the present invention is not limited to this, namely, the present invention may include the step to inspect the flexural mode, quartz crystal tuning fork resonators formed in the quartz crystal wafer therein, in other words, the step to inspect whether there is a failure resonator or not in the quartz crystal wafer. When there is a failure resonator in the wafer, something is marked on it or it is removed from the wafer or it is remembered by a computer. By including the step, it can increase the yield because it is possible to find out the failure resonator in an early step and the failure resonator does not go to the next step. As a result of which low priced flexural mode, quartz crystal tuning fork resonators can be provided with excellent electrical characteristics.

In this embodiment, the frequency adjustment is performed three times by a separate step, but may be performed at least twice by a separate step. For example, the third frequency adjustment may be omitted. In addition, in order to construct a quartz crystal oscillator, two electrode terminals of the resonators are connected electrically to an amplifier, capacitors and resistors. In other words, a quartz crystal oscillating circuit is constructed and connected electrically so that an amplification circuit comprises a CMOS inverter and a feedback resistor and a feedback circuit comprises a flexural mode, quartz crystal tuning fork resonator, a drain resistor, a capacitor of a gate side and a capacitor of a drain side. Also, the third frequency adjustment may be performed after the quartz crystal oscillating circuit was constructed in a quartz crystal unit.

Likewise, the flexural mode quartz crystal resonator of a tuning fork type has two tuning fork tines in the present embodiments, but embodiments of the present invention include tuning fork tines more than two. In addition, the quartz crystal tuning fork resonators of the present embodiments are housed in a package (unit) of a surface mounting type comprising a case and a lid, but may be housed in a package of a tubular type.

In addition, for the tuning fork resonators constructing the quartz crystal oscillators of the first embodiment to the fourth embodiment of the present invention, the resonators are provided so that a capacitance ratio r_1 of a fundamental mode vibration gets smaller than a capacitance ratio r_2 of a second overtone mode vibration, in order to obtain a frequency change of the fundamental mode vibration larger than that of the second overtone mode vibration, versus the same change of a value of load capacitance C_L . Namely, a variable range of a frequency of the fundamental mode vibration gets wider than that of the second overtone mode vibration.

In more detail, for example, when $C_L=18$ pF and the C_L changes in 1 pF, the frequency change of the fundamental mode vibration becomes larger than that of the second overtone mode vibration because the capacitance ratio r_1 is smaller than the capacitance ratio r_2 . Therefore, there is a remarkable effect for the fundamental mode vibration, such that the resonators can be provided with the frequency variable in the wide range, even when the value of load capacitance C_L changes slightly. Accordingly, when a variation of the same frequency is required, the number of capacitors which are used in the quartz crystal oscillators decreases because the frequency change versus load capacitance 1 pF becomes large, as compared with that of the second overtone mode vibration. As a result, the low priced oscillators can be provided.

Moreover, capacitance ratios r_1 and r_2 of a flexural mode, quartz crystal tuning fork resonator are given by $r_1=C_0/C_1$ and $r_2=C_0/C_2$, respectively, where C_0 is shunt capacitance in an

electrical equivalent circuit of the resonator, and C_1 and C_2 are, respectively, motional capacitance of a fundamental mode vibration and a second overtone mode vibration in the electrical equivalent circuit of the resonator. In addition, the flexural mode, quartz crystal tuning fork resonator has a quality factor Q_1 for the fundamental mode vibration and a quality factor Q_2 for the second overtone mode vibration.

In detail, the tuning fork resonator of this embodiment is provided so that the influence on resonance frequency of the fundamental mode vibration by the shunt capacitance becomes smaller than that of the second overtone mode vibration by the shunt capacitance, namely, so that it satisfies a relationship of $S_1=r_1/2Q_1^2<S_2=r_2/2Q_2^2$, preferably, $S_1<S_2/2$. As a result, the tuning fork resonator, capable of vibrating in the fundamental mode and having a high frequency stability can be provided because the influence on the resonance frequency of the fundamental mode vibration by the shunt capacitance becomes so extremely small as it can be ignored. Also, the present invention replaces $r_1/2Q_1^2$ with S_1 and $r_2/2Q_2^2$ with S_2 , respectively, and here, S_1 and S_2 are called "a stable factor of frequency" of the fundamental mode vibration and the second overtone mode vibration.

In addition, when a power source is applied to the quartz crystal oscillating circuit, at least one oscillation which satisfies an amplitude condition and a phase condition of vibration starts in the circuit, and a spent time to get to about ninety percent of the steady amplitude of the vibration is called "rise time". Namely, the shorter the rise time becomes, the easier the oscillation becomes. When rise time t_{r1} of the fundamental mode vibration and rise time t_{r2} of the second overtone mode vibration in the circuit are taken, t_{r1} and t_{r2} are given by $t_{r1}=kQ_1/(\omega_1(-1+|1-RL_1/R_1|))$ and $t_{r2}=kQ_2/(\omega_2(-1+|1-RL_2/R_2|))$, respectively, where k is constant and ω_1 and ω_2 are an angular frequency for the fundamental mode vibration and the second overtone mode vibration, respectively.

From the above-described relation, it is possible to obtain the rise time t_{r1} of the fundamental mode vibration less than the rise time t_{r2} of the second overtone mode vibration. As an example, when resonance (oscillation) frequency of a flexural mode, quartz crystal tuning fork resonator is about 32.768 kHz for a fundamental mode vibration and the resonator has a value of $W_2/W=0.5$, $t_1/t=0.34$ and $l_1/l=0.48$, though there is a distribution in production, as an example, the resonator has a value of $Q_1=62,000$ and $Q_2=192,000$, respectively. In this embodiment, Q_2 has a value of about three times of Q_1 . Accordingly, to obtain the t_{r1} less than the t_{r2} , it is necessary to satisfy a relationship of $|1-RL_1/R_1|>2|1-RL_2/R_2|-1$ by using a relation of $\omega_2=6\omega_1$ approximately. Also, according to this invention, the relationship is not limited to the quartz crystal oscillating circuit comprising the resonator in this embodiment, but this invention also includes all quartz crystal oscillating circuits to satisfy the relationship. By constructing the oscillating circuit like this, a quartz crystal oscillator with the flexural mode, quartz crystal tuning fork resonator can be provided with a short rise time. In other words, an output signal of the oscillator has an oscillation frequency of the fundamental mode vibration of the resonator and is outputted through a buffer circuit. Namely, the second overtone mode vibration can be suppressed in the oscillating circuit. In this embodiment, the resonator has also a value of $r_1=320$ and $r_2=10,600$ as an example. According to this invention, r_1 has a value of 210 to 520.

The above-described quartz crystal resonators are formed by at least one method of chemical, mechanical and physical methods. The mechanical method, for example, uses a par-

ticle such as GC#1000 and the physical method, for example, uses atom or molecule. Therefore, these methods are called "a particle method" here.

Thus, the electronic apparatus of this invention comprising a display portion and a quartz crystal oscillator at least may operate normally because the quartz crystal oscillator comprises the quartz crystal oscillating circuit with a high frequency stability, namely, a high frequency reliability.

As described above, it will be easily understood that the electronic apparatus comprising the quartz crystal oscillator comprising the quartz crystal oscillating circuit having the flexural mode, quartz crystal tuning fork resonator with novel shapes, the novel electrode construction and excellent electrical characteristics, according to the present invention, may have the outstanding effects. Similar to this, it will be easily understood that the electronic apparatus comprising the quartz crystal oscillator comprising the quartz crystal oscillating circuit having the length-extensional mode quartz crystal resonator with the novel cutting angle and the novel shape, according to the present invention, may have also the outstanding effect. In addition to this, while the present invention has been shown and described with reference to preferred embodiments thereof, it will be understood by those skilled in the art that the changes in shape and electrode construction can be made therein without departing from the spirit and scope of the present invention.

What is claimed is:

1. A method for manufacturing a quartz crystal unit, comprising the steps of:

providing a quartz crystal wafer having opposite surfaces; disposing at least one metal film on at least one of the opposite surfaces of the quartz crystal wafer to form a pattern of a tuning fork shape on the at least one of the opposite surfaces of the quartz crystal wafer;

etching the quartz crystal wafer to form a quartz crystal tuning fork resonator vibratable in flexural and fundamental modes and having a quartz crystal tuning fork base, and first and second quartz crystal tuning fork tines connected to the quartz crystal tuning fork base, each of the first and second quartz crystal tuning fork tines having a first main surface and a first side surface;

forming at least one groove having a plurality of surfaces including a first surface opposite the first side surface in the first main surface of each of the first and second quartz crystal tuning fork tines in a chemical etching process so that a width of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in a direction of the width of the at least one groove measured from an outer edge of the first surface of the at least one groove to an outer edge of the first side surface of the corresponding one of the first and second quartz crystal tuning fork tines;

disposing at least one metal film on each of the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines to form an electrode on each of the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines so that the electrode formed on the first surface of the at least one groove formed in the first main surface of the first quartz crystal tuning fork tine has the

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same electrical polarity as the electrode formed on the first side surface of the second quartz crystal tuning fork tine; and

adjusting an oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator.

2. A method according to claim 1; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration and an overall length l less than 2.18 mm, and a capacitance ratio r_1 of the fundamental mode of vibration and a capacitance ratio r_2 of the second overtone mode of vibration; wherein the width of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is less than 0.07 mm and a length l_1 of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm; wherein the ratio (l_1/l) of the length l_1 of the at least one groove and the overall length l of the quartz crystal tuning fork resonator is within a range of 0.2 to 0.78; wherein the distance in the direction of the width of the at least one groove measured from the outer edge of the first surface of the at least one groove to the outer edge of the first side surface of the corresponding one of the first and second quartz crystal tuning fork tines is less than 0.015 mm; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape, each of the quartz crystal tuning fork shape, the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the electrode formed on the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines having a dimension; and wherein the dimension of each of the quartz crystal tuning fork shape, the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the electrode formed on the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is determined so that the capacitance ratio r_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the capacitance ratio r_2 of the second overtone mode of vibration thereof and the capacitance ratio r_2 of the second overtone mode of vibration of the quartz crystal tuning fork resonator is greater than 1500.

3. A method according to claim 1; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration and an overall length less than 2.18 mm; wherein the width of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is less than 0.07 mm; wherein the distance in the direction of the width of the at least one groove measured from the outer edge of the first surface of the at least one groove to the outer edge of the first side surface of the corresponding one of the first and second quartz crystal tuning fork tines is less than 0.015 mm; wherein the quartz crystal tuning fork resonator has a capacitance ratio r_1 , a quality factor Q_1 , a merit value M_1 and a stable factor S_1 of the fundamental mode of vibration and a capacitance ratio r_2 , a quality factor Q_2 , a merit value M_2 and a stable factor S_2 of the second overtone mode of vibration; the merit value M_1 being defined by the ratio (Q_1/r_1) and the merit value M_2 being defined by the ratio (Q_2/r_2), and the stable factor S_1 being defined by the ratio $r_1/(2Q_1^2)$ and the stable factor S_2 being defined by the ratio $r_2/(2Q_2^2)$, wherein the quality factor Q_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the quality factor Q_2 of the second overtone mode of vibration thereof; wherein when the at least

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one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines extends into the quartz crystal tuning fork base and a length of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and extending into the quartz crystal tuning fork base is defined by l_1 , a length of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is defined by l_1-l_3 , where l_3 represents a length of the at least one groove formed in the quartz crystal tuning fork base; wherein the at least one groove is formed in the first main surface of each of the first and second quartz crystal tuning fork tines so that the length l_3 is substantially zero; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape, and wherein a dimension of each of the quartz crystal tuning fork shape, the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the electrode formed on the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is determined so that the capacitance ratio r_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the capacitance ratio r_2 of the second overtone mode of vibration thereof and the merit value M_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is greater than the merit value M_2 of the second overtone mode of vibration thereof, and the stable factor S_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the stable factor S_2 of the second overtone mode of vibration thereof.

4. A method according to claim 3; wherein the dimension of each of the quartz crystal tuning fork shape, the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the electrode formed on the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is determined so that the merit value M_2 of the second overtone mode of vibration of the quartz crystal tuning fork resonator is less than 30; and further including the steps of providing a case having a mounting portion and a lid; mounting the quartz crystal tuning fork resonator on the mounting portion of the case; and connecting the lid to the case.

5. A method according to claim 1; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration, each of the first and second quartz crystal tuning fork tines having a second main surface opposite the first main surface; wherein the forming step of the at least one groove includes the step of forming a groove in the second main surface of each of the first and second quartz crystal tuning fork tines; wherein the forming step of the electrode includes the step of forming a first electrode on a surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape, each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and

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second quartz crystal tuning fork tines having a dimension; and wherein the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that a capacitance ratio r_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than a capacitance ratio r_2 of the second overtone mode of vibration thereof.

6. A method according to claim 5; wherein the quartz crystal tuning fork resonator has an overall length within a range of 1.2 mm to 2 mm; wherein the quartz crystal tuning fork base has a length l_2 less than 0.5 mm; and wherein the groove is formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm and a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 0.07 mm, a first distance in the width direction of the groove measured from a first outer edge of the groove to a first outer edge of the corresponding one of the first and second quartz crystal tuning fork tines being defined by W_1 and a second distance in the width direction of the groove measured from a second outer edge opposite the first outer edge of the groove to a second outer edge opposite the first outer edge of the corresponding one of the first and second quartz crystal tuning fork tines being defined by W_3 , and so that at least one of the first distance W_1 and the second distance W_3 is less than 0.015 mm.

7. A method according to claim 6; wherein each of the first distance W_1 and the second distance W_3 is less than 0.015 mm.

8. A method according to claim 5; wherein the quartz crystal wafer has a cutting angle; wherein the quartz crystal tuning fork resonator has a piezoelectric constant e'_{12} to drive the quartz crystal tuning fork resonator; and further including the step of determining the cutting angle of the quartz crystal wafer and the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the quartz crystal tuning fork resonator has the piezoelectric constant e'_{12} within a range of 0.12 C/m² to 0.19 C/m² in the absolute value.

9. A method according to claim 5; wherein a width W of each of the first and second quartz crystal tuning fork tines is less than 0.18 mm; and wherein the groove is formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than a spaced-apart distance between the first and second quartz crystal tuning fork tines and a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm, and so that the width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the width direction of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and is within a range of 0.03 mm to 0.12 mm.

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10. A method according to claim 9; wherein each of the first and second quartz crystal tuning fork tines has a length; and wherein the groove is formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is substantially uniform along the length of the corresponding one of the first and second quartz crystal tuning fork tines and less than 0.07 mm.

11. A method according to claim 5; wherein a spaced-apart distance W_4 between the first and second quartz crystal tuning fork tines is within a range of 0.05 mm to 0.35mm; and further including the step of providing a case having a mounting portion and a lid for covering an open end of the case and the sequential steps of forming the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines each having a width W less than 0.18 mm so that the spaced-apart distance between the first and second quartz crystal tuning fork tines is within the range of 0.05 mm to 0.35mm; forming the groove in the second main surface of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than the spaced-apart distance W_4 between the first and second quartz crystal tuning fork tines and a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm, and so that the width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and is within a range of 0.03 mm to 0.12 mm; forming the first electrode on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a first preselected oscillation frequency; mounting the quartz crystal tuning fork resonator on the mounting portion of the case; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a second preselected oscillation frequency; and connecting the lid to the case to cover the open end of the case in a vacuum.

12. A method according to claim 11; wherein the first preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; and wherein the second preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm.

13. A method according to claim 5; wherein a spaced-apart distance W_4 between the first and second quartz crystal tuning fork tines is within a range of 0.05 mm to 0.35mm; and further including the step of providing a case having a mounting portion and a through-hole, and a lid for covering an open end of the case and the sequential steps of forming the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines each having a width W less than 0.18 mm so that the spaced-apart distance between the first and second quartz crystal tuning fork tines is within the range of 0.05 mm to 0.35mm; forming the groove in the second main surface of

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each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than the spaced-apart distance W_4 between the first and second quartz crystal tuning fork tines and a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm, and so that the width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and is within a range of 0.03 mm to 0.12 mm; forming the first electrode on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a first preselected oscillation frequency; mounting the quartz crystal tuning fork resonator on the mounting portion of the case; connecting the lid to the case to cover the open end of the case; and disposing a metal or a glass in the through-hole of the case to close the through-hole thereof in a vacuum.

14. A method according to claim 13; wherein the first preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; and further including the step of adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a second preselected oscillation frequency after the mounting step and before the disposing step of the metal or the glass or adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a third preselected oscillation frequency after the disposing step; wherein the second preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; and wherein the third preselected oscillation frequency, is about 32.768 kHz with a frequency deviation within a range of -50 ppm to +50 ppm.

15. A method according to claim 5; wherein each of the first and second quartz crystal tuning fork tines has a width W less than 0.18 mm; and further including the step of providing a case having a mounting portion and a lid for covering an open end of the case and the sequential steps of forming simultaneously the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines and the groove in the second main surface of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than a spaced-apart distance W_4 between the first and second quartz crystal tuning fork tines and a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm, and so that the width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than 0.07 mm; forming the first electrode on the surface of the groove formed in the second main

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surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; mounting the quartz crystal tuning fork resonator on the mounting portion of the case; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; and connecting the lid to the case to cover the open end of the case in a vacuum.

16. A method according to claim 1; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; wherein the opposite surfaces of the quartz crystal wafer have a first surface and a second surface; and further including the steps of disposing at least one first metal film on each of the first and second surfaces of the quartz crystal wafer; disposing a first resist on the at least one first metal film; forming a pattern of a tuning fork shape on each of the first and second surfaces of the quartz crystal wafer; forming a quartz crystal tuning fork shape having the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines each having a width W less than 0.18 mm; forming a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than 0.07 mm and a length of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm; removing the first resist disposed on the at least one first metal film; disposing at least one second metal film on each of the first and second main surfaces and the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines; disposing a second resist on the at least one second metal film; forming a first electrode on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and

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second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; removing the second resist disposed on the at least one second metal film; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a first preselected oscillation frequency; mounting the quartz crystal tuning fork resonator on a mounting portion of a case; after the mounting step, adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to a second preselected oscillation frequency; and connecting a lid to the case to cover an open end of the case.

17. A method according to claim 16; wherein the adjusting step of the first preselected oscillation frequency is performed after the forming step of the first and second electrodes and before the mounting step so that the first preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; wherein the second preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; wherein the quartz crystal tuning fork resonator has an overall length and a second overtone mode of vibration; and further including the step of determining the overall length of the quartz crystal tuning fork resonator and the length of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a series resistance R_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than a series resistance R_2 of the second overtone mode of vibration thereof.

18. A method according to claim 17; wherein the case has a through-hole; and further including the step of disposing a metal or a glass into the through-hole of the case to close the through-hole thereof in a vacuum after the connecting step of the lid and the case; wherein the adjusting step of the second preselected oscillation frequency is performed after the disposing step of the metal or the glass so that the second preselected oscillation frequency is about 32.768 kHz with a frequency deviation within a range of -50 ppm to +50 ppm; wherein the forming step of the quartz crystal tuning fork shape having the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines is performed before the forming step of the groove having the at least three surfaces; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration; and further including the step of determining a dimension of each of the quartz crystal tuning fork shape, the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a capacitance ratio r_2 of the second overtone mode of vibration of the quartz crystal tuning fork resonator is greater than 1500.

19. A method according to claim 1; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; wherein the opposite surfaces of the quartz crystal wafer have a first surface and a second surface; and further including the sequential steps of disposing at least one first metal film on each of the first and second surfaces of the quartz crystal wafer; disposing a first resist on the at least one first metal film; forming a pattern of a tuning fork shape on each of the

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first and second surfaces of the quartz crystal wafer; forming a quartz crystal tuning fork shape having the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines; forming a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than a spaced-apart distance between the first and second quartz crystal tuning fork tines, and a length of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm; disposing at least one second metal film on each of the first and second main surfaces and the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines; disposing a second resist on the at least one second metal film; forming a first electrode on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; removing the second resist disposed on the at least one second metal film; mounting the quartz crystal tuning fork resonator on a mounting portion of a case; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator; and connecting a lid to the case to cover an open end of the case.

20. A method according to claim 19; wherein the case has a through-hole; and further including the steps of disposing a metal or a glass into the through-hole of the case to close the through-hole thereof in a vacuum after the connecting step of the lid and the case; and adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator after the disposing step of the metal or the glass so that the oscillation frequency of the fundamental mode of vibration thereof is about 32.768 kHz with a frequency deviation within a range of -50 ppm to +50 ppm.

21. A method according to claim 19; wherein the adjusting step of the oscillation frequency includes the step of adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator so that the oscillation frequency of the fundamental mode of vibration thereof is about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; and wherein the connecting step of the lid and the case includes the step of connecting the lid to the case in a vacuum.

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22. A method according to claim 19; wherein the adjusting step of the oscillation frequency includes the step of adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator so that the oscillation frequency of the fundamental mode of vibration thereof is about 32.768 kHz with a frequency deviation within a range of 31 100 ppm to +100 ppm; wherein the case has a through-hole; and further including the step of disposing a metal or a glass into the through-hole of the case to close the through-hole thereof in a vacuum after the connecting step of the lid and the case.

23. A method according to claim 1; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; wherein the opposite surfaces of the quartz crystal wafer have a first surface and a second surface; and further including the step of forming a pattern of a tuning fork shape on each of the first and second surfaces of the quartz crystal wafer; wherein the forming step of the at least one groove includes the step of forming simultaneously the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines and a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than 0.07 mm, and a length of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm; and further including the steps of disposing at least one metal film on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines to form a first electrode on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; mounting the quartz crystal tuning fork resonator on a mounting portion of a case; and connecting a lid to the case to cover an open end of the case; wherein the adjusting step includes the steps of adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator after the forming step of the first and second electrodes and before the mounting step so that the oscillation frequency of the fundamental mode

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of vibration thereof is about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm and adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator after the mounting step and before the connecting step of the lid and the case so that the oscillation frequency of the fundamental mode of vibration thereof is about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm.

24. A method for manufacturing a quartz crystal oscillator having a quartz crystal oscillating circuit, comprising the steps of:

providing a quartz crystal wafer having opposite surfaces; disposing at least one metal film on at least one of the opposite surfaces of the quartz crystal wafer to form a pattern of a tuning fork shape on the at least one of the opposite surfaces of the quartz crystal wafer;

etching the quartz crystal wafer to form a quartz crystal tuning fork resonator vibratable in flexural and fundamental modes and having a quartz crystal tuning fork base, and first and second quartz crystal tuning fork tines connected to the quartz crystal tuning fork base, each of the first and second quartz crystal tuning fork tines having a first main surface and a first side surface;

forming at least one groove having a plurality of surfaces including a first surface opposite the first side surface in the first main surface of each of the first and second quartz crystal tuning fork tines in a chemical etching process so that a width of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the at least one groove measured from an outer edge of the first surface of the at least one groove to an outer edge of the first side surface of the corresponding one of the first and second quartz crystal tuning fork tines;

disposing at least one metal film on each of the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines to form an electrode on each of the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines so that the electrode formed on the first surface of the at least one groove formed in the first main surface of the first quartz crystal tuning fork tine has the same electrical polarity as the electrode formed on the first side surface of the second quartz crystal tuning fork tine;

adjusting an oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator;

providing an amplifier, at least one resistor and a plurality of capacitors; and

electrically connecting the quartz crystal tuning fork resonator to each of the amplifier, the at least one resistor and the capacitors.

25. A method according to claim 24; wherein the quartz crystal tuning fork resonator has an overall length less than 2.18 mm; wherein the quartz crystal tuning fork base has a length l_2 less than 0.5 mm, each of the first and second quartz crystal tuning fork tines having a second main surface opposite the first main surface; and wherein the forming step of the at least one groove includes the step of forming a groove in the second main surface of each of the first and second quartz crystal tuning fork tines so that a length of the groove formed

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in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm and a width of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is less than 0.07 mm, a first distance in the direction of the width of the groove formed in the second main surface is measured from a first outer edge of the groove to a first outer edge of the corresponding one of the first and second quartz crystal tuning fork tines being defined by W_1 and a second distance in the direction of the width of the groove formed in the second main surface is measured from a second outer edge opposite the first outer edge of the groove to a second outer edge opposite the first outer edge of the corresponding one of the first and second quartz crystal tuning fork tines being defined by W_3 , and so that at least one of the first distance W_1 and the second distance W_3 is less than 0.015 mm.

26. A method according to claim 24; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration; wherein the quartz crystal tuning fork resonator has a capacitance ratio r_1 of the fundamental mode of vibration and a capacitance ratio r_2 of the second overtone mode of vibration; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface; wherein the forming step of the at least one groove includes the step of forming a groove in the second main surface of each of the first and second quartz crystal tuning fork tines; wherein a first electrode is formed on a surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape, each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines having a dimension; wherein the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the capacitance ratio r_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the capacitance ratio r_2 of the second overtone mode of vibration thereof; wherein the quartz crystal tuning fork resonator has an angular frequency ω_1 , a series resistance R_1 and a quality factor Q_1 of the fundamental mode of vibration and an angular frequency ω_2 , a series resistance R_2 and a quality factor Q_2 of the second overtone mode of vibration; wherein the quartz crystal oscillating circuit has the quartz crystal tuning fork resonator, a negative resistance $-RL_1$ of the fundamental mode of vibration of the quartz crystal tuning fork resonator and a negative resistance $-RL_2$ of the second overtone mode of vibration thereof, $|-RL_1|$ representing the absolute value of the negative resistance $-RL_1$ and $|-RL_2|$ representing the absolute value of the negative resistance $-RL_2$; wherein a rise time t_{r1} of the fundamental mode of vibration of the quartz crystal tuning fork resonator in the quartz crystal oscillating circuit is defined by $t_{r1}=kQ_1/(\omega_1(-1 \times |-RL_1|/R_1))$ and a rise time t_{r2} of the second overtone

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mode of vibration of the quartz crystal tuning fork resonator therein is defined by $t_{r2}=kQ_2/(\omega_2(-1 \times |-RL_2|/R_2))$, where k is a constant value; wherein each of the $|-RL_1|$, the $|-RL_2|$ and the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the rise time t_{r1} is less than the rise time t_{r2} ; wherein the quartz crystal oscillating circuit having the quartz crystal tuning fork resonator is housed in an electronic apparatus having a display portion; and wherein an output signal of the quartz crystal oscillating circuit having the quartz crystal tuning fork resonator is a clock signal for use in operation of the electronic apparatus to display time information at the display portion, the clock signal having the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator of about 32.768 kHz with a frequency deviation within a range of -100 ppm to $+100$ ppm.

27. A method according to claim 24; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; wherein the opposite surfaces of the quartz crystal wafer have a first surface and a second surface; and further including the sequential steps of disposing at least one first metal film on each of the first and second surfaces of the quartz crystal wafer; disposing a first resist on the at least one first metal film; forming a pattern of a tuning fork shape on each of the first and second surfaces of the quartz crystal wafer; forming a quartz crystal tuning fork shape having an overall length l and the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines so that a width W of each of the first and second quartz crystal tuning fork tines is less than 0.18 mm and a spaced-apart distance between the first and second quartz crystal tuning fork tines is within a range of 0.05 mm to 0.35 mm, and the quartz crystal tuning fork base has a first base portion including a first width W_5 , a second base portion including a second width W_6 greater than the first width W_5 and a third base portion including a third width less than each of the first width W_5 and the second width W_6 , the third base portion being formed between the first and second base portions; forming a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the width direction of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than the spaced-apart distance between the first and second quartz crystal tuning fork tines and less than 0.07 mm, and a length l of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm and the ratio (l/l_1) of the length l_1 of the groove and the overall length l of the quartz crystal tuning fork shape is within a range of 0.2 to 0.78; disposing at least one second metal film on each of the first and second main surfaces and the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the

groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines; disposing a second resist on the at least one second metal film; forming a first electrode on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; removing the second resist disposed on the at least one second metal film; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; mounting the quartz crystal tuning fork resonator on a mounting portion of a case having a through-hole; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -950 ppm to +950 ppm; connecting a lid to the case to cover an open end of the case; and disposing a metal or a glass into the through-hole of the case to close the through-hole thereof in a vacuum.

28. A method according to claim 24; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; wherein the opposite surfaces of the quartz crystal wafer have a first surface and a second surface; and further including the sequential steps of disposing at least one first metal film on each of the first and second surfaces of the quartz crystal wafer; disposing a first resist on the at least one first metal film; forming a pattern of a tuning fork shape on each of the first and second surfaces of the quartz crystal wafer; forming a quartz crystal tuning fork shape having an overall length l and the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines so that a width W of each of the first and second quartz crystal tuning fork tines is less than 0.18 mm and a spaced-apart distance between the first and second quartz crystal tuning fork tines is within a range of 0.05 mm to 0.35 mm; forming a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the width direction of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than the spaced-apart distance between the first and second quartz crystal tuning fork tines and less than 0.07 mm, and a length l_1 of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm and the ratio

(l_1/l) of the length l_1 of the groove and the overall length l of the quartz crystal tuning fork shape is within a range of 0.2 to 0.78; disposing at least one second metal film on each of the first and second main surfaces and the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines; disposing a second resist on the at least one second metal film; forming a first electrode on each of the first and second main surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; removing the second resist disposed on the at least one second metal film; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; mounting the quartz crystal tuning fork resonator on a mounting portion of a case; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; and connecting a lid to the case to cover an open end of the case in a vacuum.

29. A method according to claim 24; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface and a second side surface opposite the first side surface, the first side surface of the first quartz crystal tuning fork tine confronting the second side surface of the second quartz crystal tuning fork tine; and further including the sequential steps of forming simultaneously a quartz crystal tuning fork shape having an overall length l and the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines and a groove having at least three surfaces including a first surface opposite the first side surface and a second surface connected to the first surface through a third surface in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines so that a width W of each of the first and second quartz crystal tuning fork tines is less than 0.18 mm and a width of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is greater than a distance in the width direction of the groove measured from an outer edge of the groove to an outer edge of the corresponding one of the first and second quartz crystal tuning fork tines and less than a spaced-apart distance between the first and second quartz crystal tuning fork tines and less than 0.07 mm, and a length l_1 of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines is less than 1.29 mm and the ratio (l_1/l) of the length l_1 of the groove and the overall length l of the quartz crystal tuning fork shape is within a range of 0.2 to 0.78; disposing at least one second metal film on each of the first and second

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main surfaces and the first and second side surfaces of each of the first and second quartz crystal tuning fork tines, and each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines; disposing a second resist on the at least one second metal film; forming a first electrode on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of each of the first and second quartz crystal tuning fork tines and a second electrode on each of the first and second side surfaces of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the first quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the second quartz crystal tuning fork tine, and the first electrode formed on each of the first and second surfaces of the groove formed in each of the first and second main surfaces of the second quartz crystal tuning fork tine has the same electrical polarity as the second electrode formed on each of the first and second side surfaces of the first quartz crystal tuning fork tine; removing the second resist disposed on the at least one second metal film; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -9000 ppm to +5000 ppm; mounting the quartz crystal tuning fork resonator on a mounting portion of a case; adjusting the oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator to about 32.768 kHz with a frequency deviation within a range of -100 ppm to +100 ppm; and connecting a lid to the case to cover an open end of the case in a vacuum.

30. A method for manufacturing an electronic apparatus having at least one quartz crystal oscillating circuit and a display portion, comprising the steps of:

providing a quartz crystal wafer having opposite surfaces; disposing at least one metal film on at least one of the opposite surfaces of the quartz crystal wafer to form a pattern of a tuning fork shape on the at least one of the opposite surfaces of the quartz crystal wafer;

etching the quartz crystal wafer to form a quartz crystal tuning fork resonator vibratable in flexural and fundamental modes and having a quartz crystal tuning fork base, and first and second quartz crystal tuning fork tines connected to the quartz crystal tuning fork base, each of the first and second quartz crystal tuning fork tines having a first main surface and a first side surface;

forming at least one groove having a plurality of surfaces including a first surface opposite the first side surface in the first main surface of each of the first and second quartz crystal tuning fork tines in a chemical etching process so that a width of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines is greater than a distance in the direction of the width of the at least one groove measured from an outer edge of the first surface of the at least one groove to an outer edge of the first side surface of the corresponding one of the first and second quartz crystal tuning fork tines;

disposing at least one metal film on each of the first surface of the at least one groove formed in the first main surface of each of the first and second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines to form an electrode on each of the first surface of the at least one groove formed in the first main surface of each of the first and

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second quartz crystal tuning fork tines and the first side surface of each of the first and second quartz crystal tuning fork tines so that the electrode formed on the first surface of the at least one groove formed in the first main surface of the first quartz crystal tuning fork tine has the same electrical polarity as the electrode formed on the first side surface of the second quartz crystal tuning fork tine; and

adjusting an oscillation frequency of the fundamental mode of vibration of the quartz crystal tuning fork resonator;

wherein the at least one quartz crystal oscillating circuit has the quartz crystal tuning fork resonator, an amplifier, at least one resistor and a plurality of capacitors, the quartz crystal tuning fork resonator being electrically connected to each of the amplifier, the at least one resistor and the capacitors; and

wherein an output signal of the at least one quartz crystal oscillating circuit having the quartz crystal tuning fork resonator is a clock signal for use in operation of the electronic apparatus to display time information at the display portion.

31. A method according to claim 30; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration; wherein the quartz crystal tuning fork resonator has a capacitance ratio r_1 , a quality factor Q_1 , a merit value M_1 and a stable factor S_1 of the fundamental mode of vibration and a capacitance ratio r_2 , a quality factor Q_2 , a merit value M_2 and a stable factor S_2 of the second overtone mode of vibration, the merit value M_1 being defined by the ratio (Q_1/r_1) and the merit value M_2 being defined by the ratio (Q_2/r_2) , and the stable factor S_1 being defined by the ratio $r_1/(2Q_1^2)$ and the stable factor S_2 being defined by the ratio $r_2/(2Q_2^2)$, wherein the quality factor Q_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the quality factor Q_2 of the second overtone mode of vibration thereof; wherein each of the first and second quartz crystal tuning fork tines has a second main surface opposite the first main surface; wherein the forming step of the at least one groove includes the step of forming a groove in the second main surface of each of the first and second quartz crystal tuning fork tines; wherein when the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines extends into the quartz crystal tuning fork base and a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and extending into the quartz crystal tuning fork base is defined by l_1 , a length of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is defined by l_1-l_3 , where l_3 represents a length of the groove formed in the quartz crystal tuning fork base; wherein the groove is formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the length l_3 is substantially zero; wherein a first electrode is formed on a surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape, each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the

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first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines having a dimension; wherein the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the stable factor S_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the stable factor S_2 of the second overtone mode of vibration thereof, and the merit value M_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is greater than the merit value M_2 of the second overtone mode of vibration thereof; wherein the quartz crystal tuning fork resonator has a series resistance R_1 of the fundamental mode of vibration and a series resistance R_2 of the second overtone mode of vibration; wherein the at least one quartz crystal oscillating circuit has a negative resistance $-RL_1$ of the fundamental mode of vibration of the quartz crystal tuning fork resonator and a negative resistance $-RL_2$ of the second overtone mode of vibration thereof, $|-RL_1|$ representing the absolute value of the negative resistance $-RL_1$ and $|-RL_2|$ representing the absolute value of the negative resistance $-RL_2$; and wherein each of the $|-RL_1|$, the $|-RL_2|$ and the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the ratio $|-RL_1|/R_1$ is greater than $2|-RL_2|/R_2-1$.

32. A method according to claim **31**; wherein the series resistance R_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the series resistance R_2 of the second overtone mode of vibration thereof; wherein the quality factor Q_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the quality factor Q_2 of the second overtone mode of vibration thereof; wherein the quartz crystal tuning fork resonator has a shunt capacitance; wherein a frequency difference of a mechanical resonance frequency independent on the shunt capacitance of the fundamental mode of vibration of the quartz crystal tuning fork resonator and a resonance frequency dependent on the shunt capacitance of the fundamental mode of vibration thereof is defined by Δf_1 ; wherein a frequency difference of a mechanical resonance frequency independent on the shunt capacitance of the second overtone mode of vibration of the quartz crystal tuning fork resonator and a resonance frequency dependent on the shunt capacitance of the second overtone mode of vibration thereof is defined by Δf_2 ; and wherein the dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the frequency differences Δf_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the frequency difference Δf_2 of the second overtone mode of vibration thereof.

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33. A method according to claim **30**; wherein the quartz crystal tuning fork resonator has a second overtone mode of vibration, each of the first and second quartz crystal tuning fork tines having a second main surface opposite the first main surface; wherein the forming step of the at least one groove includes the step of forming a groove in the second main surface of each of the first and second quartz crystal tuning fork tines; wherein a first electrode is formed on a surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines so that the first electrode formed on the surface of the groove formed in the second main surface of the first quartz crystal tuning fork tine has an electrical polarity opposite to an electrical polarity of the first electrode formed on the surface of the groove formed in the second main surface of the second quartz crystal tuning fork tine; wherein the quartz crystal tuning fork base, and the first and second quartz crystal tuning fork tines have a quartz crystal tuning fork shape; wherein the quartz crystal tuning fork resonator has a capacitance ratio r_1 , an angular frequency ω_1 , a series resistance R_1 and a quality factor Q_1 of the fundamental mode of vibration and a capacitance ratio r_2 , an angular frequency ω_2 , a series resistance R_2 and a quality factor Q_2 of the second overtone mode of vibration; wherein the at least one quartz crystal oscillating circuit comprises a first quartz crystal oscillating circuit having the quartz crystal tuning fork resonator, a negative resistance $-RL_1$ of the fundamental mode of vibration of the quartz crystal tuning fork resonator and a negative resistance $-RL_2$ of the second overtone mode of vibration thereof, $|-RL_1|$ representing the absolute value of the negative resistance $-RL_1$ and $|-RL_2|$ representing the absolute value of the negative resistance $-RL_2$; wherein a rise time t_{r1} of the fundamental mode of vibration of the quartz crystal tuning fork resonator in the first quartz crystal oscillating circuit is defined by $t_{r1}=kQ_1/(\omega_1(-1+|-RL_1|/R_1))$ and a rise time t_{r2} of the second overtone mode of vibration of the quartz crystal tuning fork resonator therein is defined by $t_{r2}=kQ_2/(\omega_2(-1+|-RL_2|/R_2))$ where k is a constant value; wherein each of the $|-RL_1|$, the $|-RL_2|$ and a dimension of each of the quartz crystal tuning fork shape, the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines and the first electrode formed on the surface of the groove formed in the second main surface of each of the first and second quartz crystal tuning fork tines is determined so that the rise time t_{r1} is less than the rise time t_{r2} ; wherein an output signal of the first quartz crystal oscillating circuit having the quartz crystal tuning fork resonator is a clock signal for use in operation of the electronic apparatus to display time information at the display portion; wherein the quality factor Q_1 of the fundamental mode of vibration of the quartz crystal tuning fork resonator is less than the quality factor Q_2 of the second overtone mode of vibration thereof; wherein the at least one quartz crystal oscillating circuit comprises a second quartz crystal oscillating circuit having a thickness shear mode quartz crystal resonator; and wherein an output signal of the second quartz crystal oscillating circuit having the thickness shear mode quartz crystal resonator is a clock signal for use in operation of the electronic apparatus.

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